

**SERVICE & OPERATION
MANUAL**

CONTINUOUS DUTY

P25-02L1-C1

P25-05L1-C1

P25- 2L1-C1

P25-15L1-C1

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SECTION I

General Information

1.1 General Description

Milcom RF Power Amplifiers are designed to be used with communications equipment operating in the HF Band of 2 to 30 MHz. The VHF band of 30 to 300 MHz and the UHF band of 300 to 3000 MHz. Models are available for FM, AM and SSB operation.

Operation with a transceiver is simplified through the use of an internal RF actuated amplifier bypass circuit. During receive this circuit routes the signal around the RF power amplifier. During transmit this circuit automatically switches the RF power amplifier in line. RF power amplifiers for repeater operation have no need of, and therefore are not supplied with this bypass circuit.

Amplifiers intended for AM and SSB applications include an RF actuated bias circuit. This circuit automatically applies bias only during the power amplifier transmit periods. A leveling circuit is also available to maintain transmit periods. A leveling circuit is also available to maintain power output over wide variations of frequency and input power.

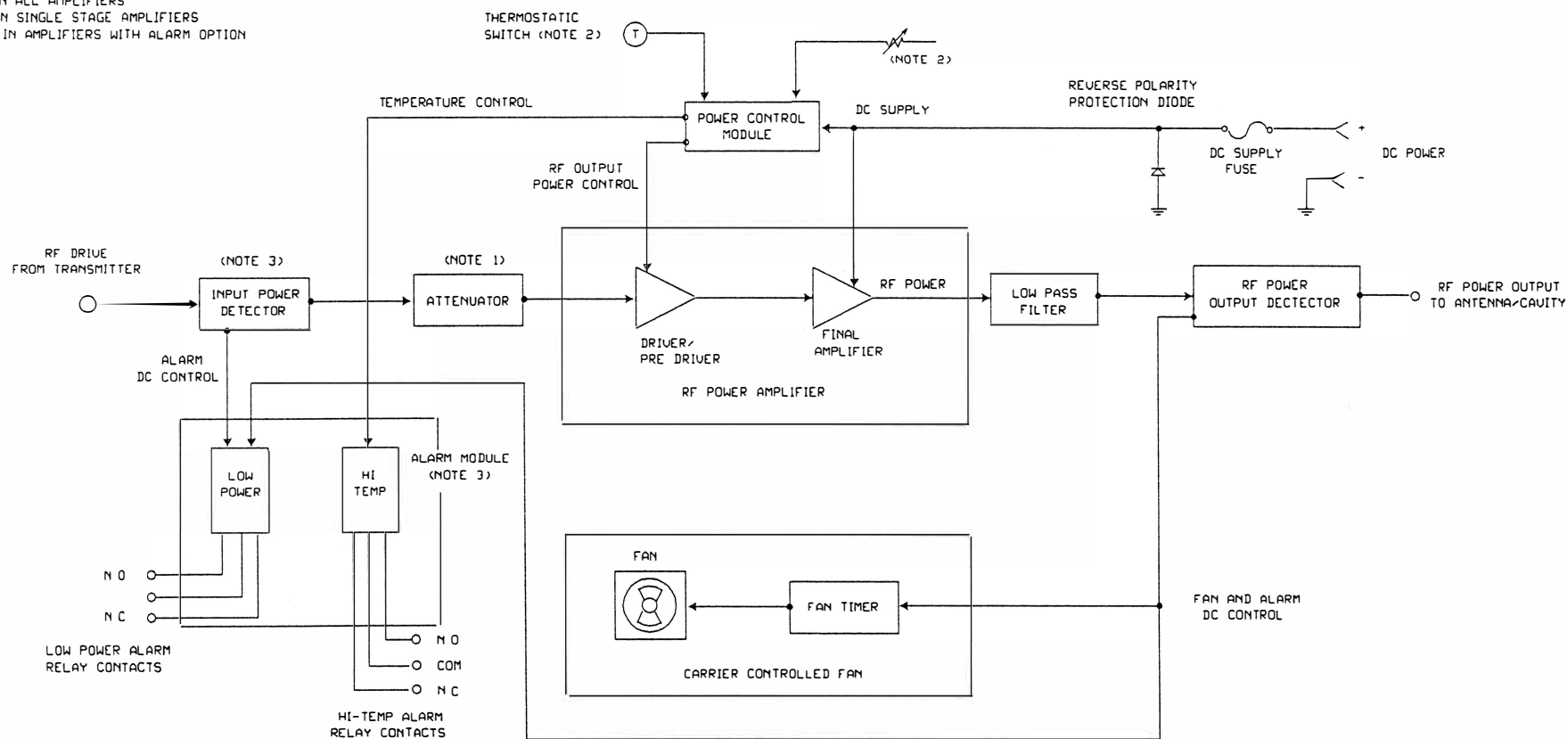
The amplifiers manufactured by Milcom are proven designs utilizing a combination of advanced technologies such as ferrite transformers, microstrip matching and quadrature combiners to provide broad band performance and high reliability.

1.2 TYPICAL BLOCK DIAGRAMS

Figures 1.1 through 1.4 show typical block diagrams of Milcom designed amplifiers. These diagrams are presented as an aid to understanding Milcom's design approach, and not necessarily to assist in trouble shooting amplifier malfunctions.

NOTES

- 1 THIS MODULE NOT INCLUDED IN ALL AMPLIFIERS
- 2 THIS MODULE NOT INCLUDED IN SINGLE STAGE AMPLIFIERS
- 3 THIS MODULE INCLUDED ONLY IN AMPLIFIERS WITH ALARM OPTION

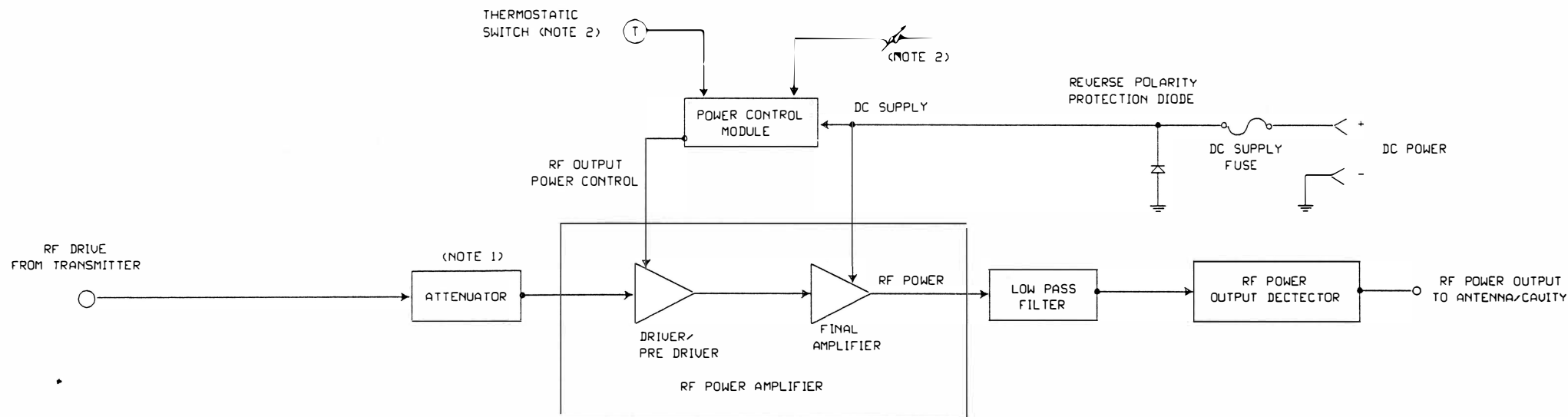


BLOCK DIAGRAM
100% DUTY CYCLE AMPLIFIERS
FOR REPEATER AND TRUNK APPLICATIONS

Fig. 1.1

MILCOM INTERNATIONAL Milcom 10891 CAPITAL AVE GARDEN GROVE, CA 92640	
SCHEMATIC DIAGRAM	
DESCRIPTION	100% DUTY CYCLE AMPLIFIER BLOCK DIAGRAM
USED ON	
MODULE ASSEMBLY NO	
CIRCUIT DESCRIPTION NO	
DRAWN BY	DATE
LINH LE	01-07-93





BLOCK DIAGRAM 50% DUTY CYCLE AMPLIFIERS FOR REPEATER AND TRUNK APPLICATIONS

NOTES

- 1 THIS MODULE NOT INCLUDED IN ALL AMPLIFIERS
- 2 THIS MODULE NOT INCLUDED IN SINGLE STAGE AMPLIFIERS

MILCOM INTERNATIONAL Milcom 10891 CAPITAL AVE GARDEN GROVE, CA 92640		
SCHEMATIC DIAGRAM		
DESCRIPTION	50% DUTY CYCLE AMPLIFIER BLOCK DIAGRAM	
USED ON		
MODULE ASSEMBLY NO		
CIRCUIT DESCRIPTION NO		
DRAWN BY	LINH LE	DATE 01-07-93
PCB PN		DWG BLK50% DWG

Fig. 1.2





BLOCK DIAGRAM MOBILE AND BASE STATION AMPLIFIERS FOR FM APPLICATIONS

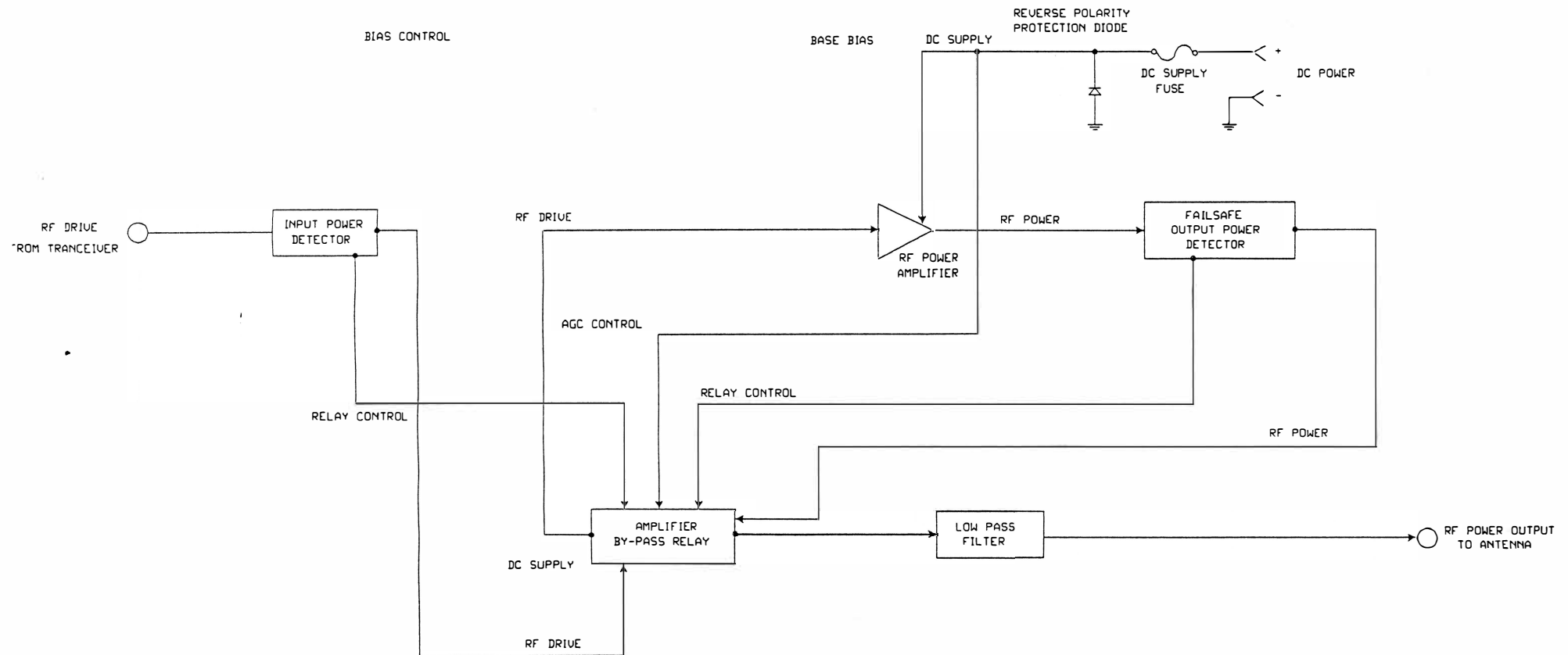
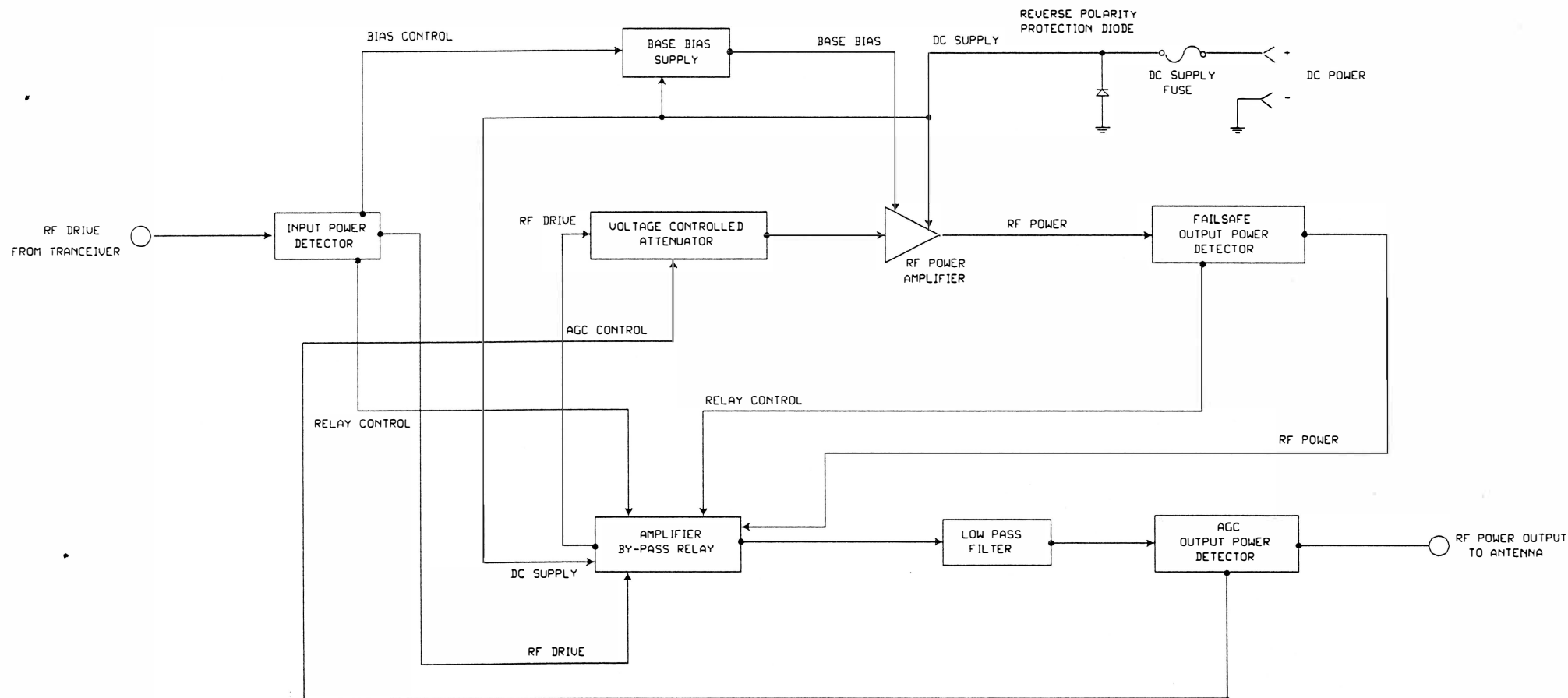


Fig. 1.3

 MILCOM INTERNATIONAL Milcom 10891 CAPITAL AVE GARDEN GROVE, CA 92640	
SCHEMATIC DIAGRAM	
DESCRIPTION	FM APPLICATIONS BLOCK DIAGRAM
USED ON	
MODULE ASSEMBLY NO	
CIRCUIT DESCRIPTION NO	
DRAWN BY	LNH LC
DATE	01-07-93
PCB PN	DWG ALKFM DWG



BLOCK DIAGRAM
 LINEAR MOBILE AND BASE STATION
 AMPLIFIERS FOR AM AND SSB APPLICATIONS

Fig. 1.4

 MILCOM INTERNATIONAL Milcom 10891 CAPITAL AVE GARDEN GROVE, CA 92640	
SCHEMATIC DIAGRAM	
DESCRIPTION AM AND SSB APPLICATIONS BLOCK DIAGRAM	
USED ON	
MODULE ASSEMBLY NO	
CIRCUIT DESCRIPTION NO	
DRAWN BY LINH LE	DATE 01-07-93
PCB PN	DWG BLKAM DWG

SECTION II

Installation

2.1 General

Before shipment, all power amplifiers undergo four levels of test and inspection:

1. Individual module testing
2. Complete power amplifier assembly testing
3. Minimum 12-hour burn-in testing
4. Final test and alignment

The amplifier is then packed in a special shipping carton along with the following accessories:

1. DC Power cable
2. Test Data sheet

2.2 Initial Inspection

If damage to the shipping carton is evident, report the extent of damage to the carrier's agent. Save all packing materials until the amplifier is inspected mechanically and electrically.

2.3 Relay Rack Mounting

The amplifier is shipped ready to mount on a standard EIA 19" relay rack or equivalent enclosed cabinet. There must be enough space around the mounted amplifier to permit free flow of cooling air.

2.4 RF Connections

The RF input/output connectors are type N female located in the back of the amplifier. See figure 2.1, Amplifier Rear View, and Figure 2.2, Amplifier Front View.

Confirm that the exciter power output level is compatible with the amplifier power input requirements. Do not exceed the maximum drive level indicated in the amplifier specifications. Page 8 shows the power input range for the different power amplifier models.

Connect the exciter output cable to the Type N input connector on the power amplifier. Connect the output of the power amplifier to the antenna or combiner input.

2.5 DC Power Connections

Figure 2.3 through 2.5 show DC power interconnections and DC power distributions. If the amplifier is supplied with a Milcom recommended power supply, the required DC and AC connecting cables are included with the power supply.

2.6 Return for Service Procedures

A Return Material Authorization (RMA) number must be obtained prior to returning equipment to the Factory for service. Please contact our service department to obtain this number. Phone number (714) 554-1710 Ext. 20. Failure to obtain this RMA number will result in considerable delays in receiving repair service.

2.7 Repacking for Shipment

To insure safe shipment of the amplifier, it is recommended that the package designed for the amplifier be used. The original packaging material is reusable. If it's not available, contact Milcom's Customer Service Department for packing materials and information.

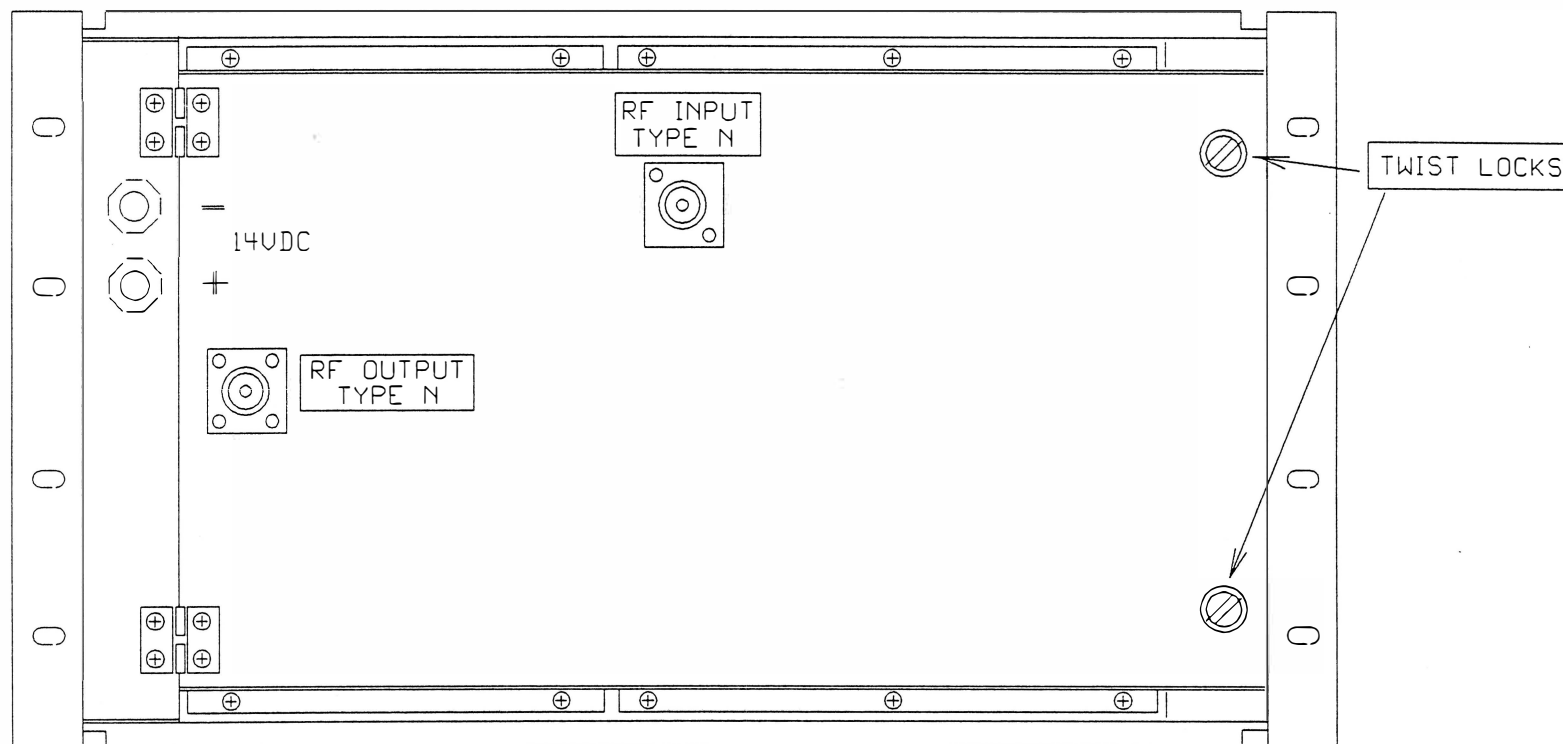
TABLE 2.8

Power Input range

930-940 MHz

<u>MODEL DESCRIPTION</u>	<u>REQUIRED POWER IN</u>	<u>MAXIMUM POWER IN</u>	<u>SPECIFIED POWER OUTPUT</u>
P25-02L1	50 milli Watts	100 mWatts	250 WATTS
P25-05L1	0.25 Watts	0.5 Watts	250 WATTS
P25- 2L1	1.5 Watts	2.0 Watts	250 WATTS
P25-15L1	10 Watts	17 WATTS	250 WATTS



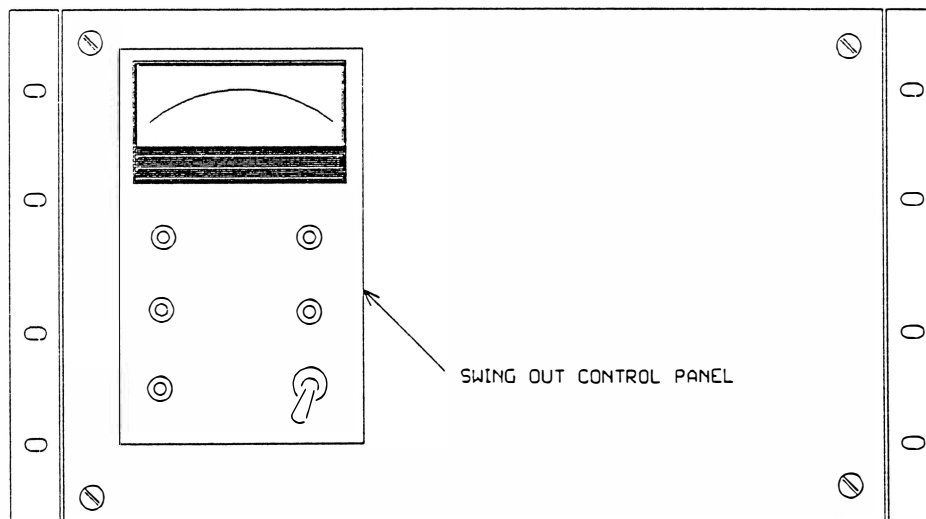


REAR VIEW

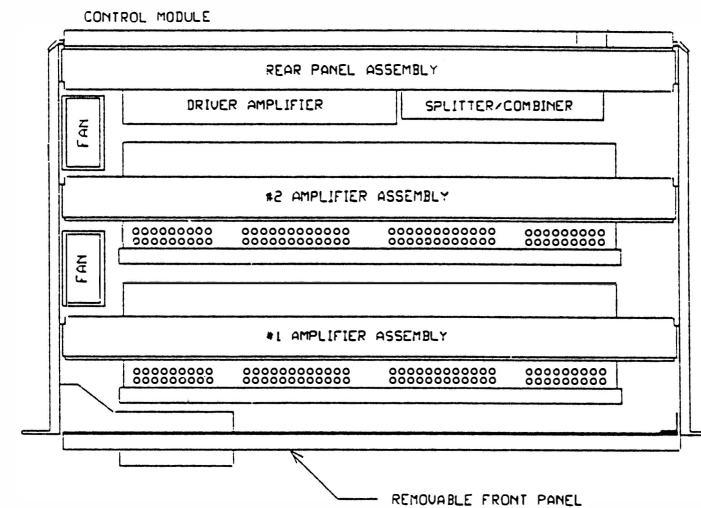
Fig. 2.1

250 WATT AMPLIFIER

MILCOM INTERNATIONAL		
10891 CAPITAL AVE GARDEN GROVE, CA 92640		
SCHEMATIC DIAGRAM		
DESCRIPTION	CB, HIGH POWER AMPLIFIER PACKAGE	
USED ON	KW SERIES, CB STAND PRODUCT	
MODULE ASSEMBLY NO		
CIRCUIT DESCRIPTION NO		
DRAWN BY	LINH U LC	DATE 12-22-92
PCB PN	REV	
TDS	950-119	RFU



FRONT VIEW



TOP VIEW

Fig. 2.2

250 WATT AMPLIFIER

MILCOM INTERNATIONAL	
10891 CAPITAL AVE GARDEN GROVE, CA 92640	
SCHEMATIC DIAGRAM	
DESCRIPTION C8, HIGH POWER AMPLIFIER PACKAGE	
USED ON KW SERIES, C8 STAND PRODUCT	
MODULE ASSEMBLY NO	
CIRCUIT DESCRIPTION NO	
DRAWN BY LINH U LE	DATE 12-22-92
PCB PN	REV
TDS 950-119	REV:

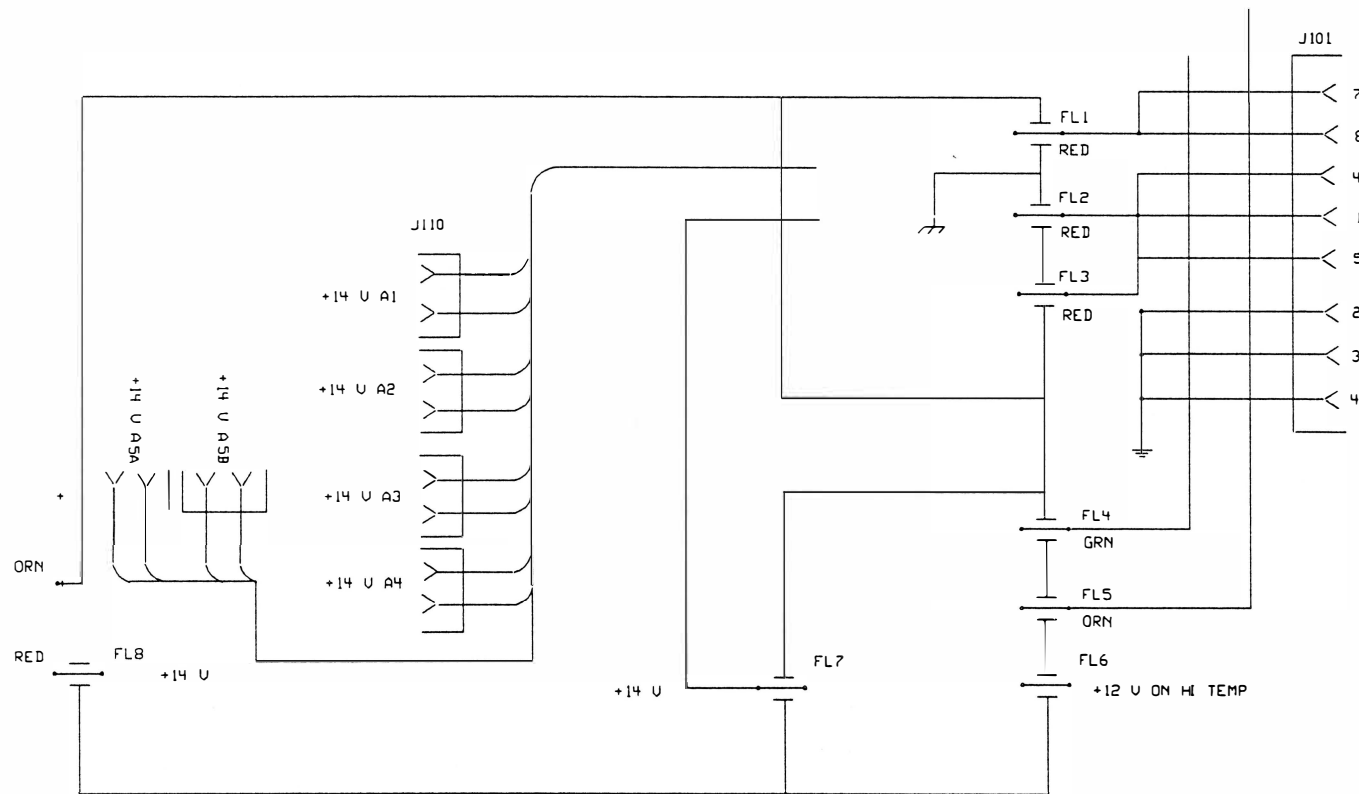


Fig. 2.3

 MILCOM INTERNATIONAL Milcom 10891 CAPITAL AVE GARDEN GROVE, CA 92640		
PRODUCT	ASSEMBLY REFERENCE NO	SCHEMATIC DIAGRAM
P15-02L1	NONE	DESCRIPTION DC INTERCONNECTIONS 90 WATTS & 150 WATTS RF AMPLIFIERS 806 TO 890 MHz
P15-05L1		MODULE ASSEMBLY NO NOT APPLICABLE
P15-2L1		CIRCUIT DESCRIPTION NO N/A
P15-15L1		DRAWN BY R. HEILMAN DATE 01-12-93
P25-05L1		PCB PN N/A REV
P25-2L1		TDS REV A

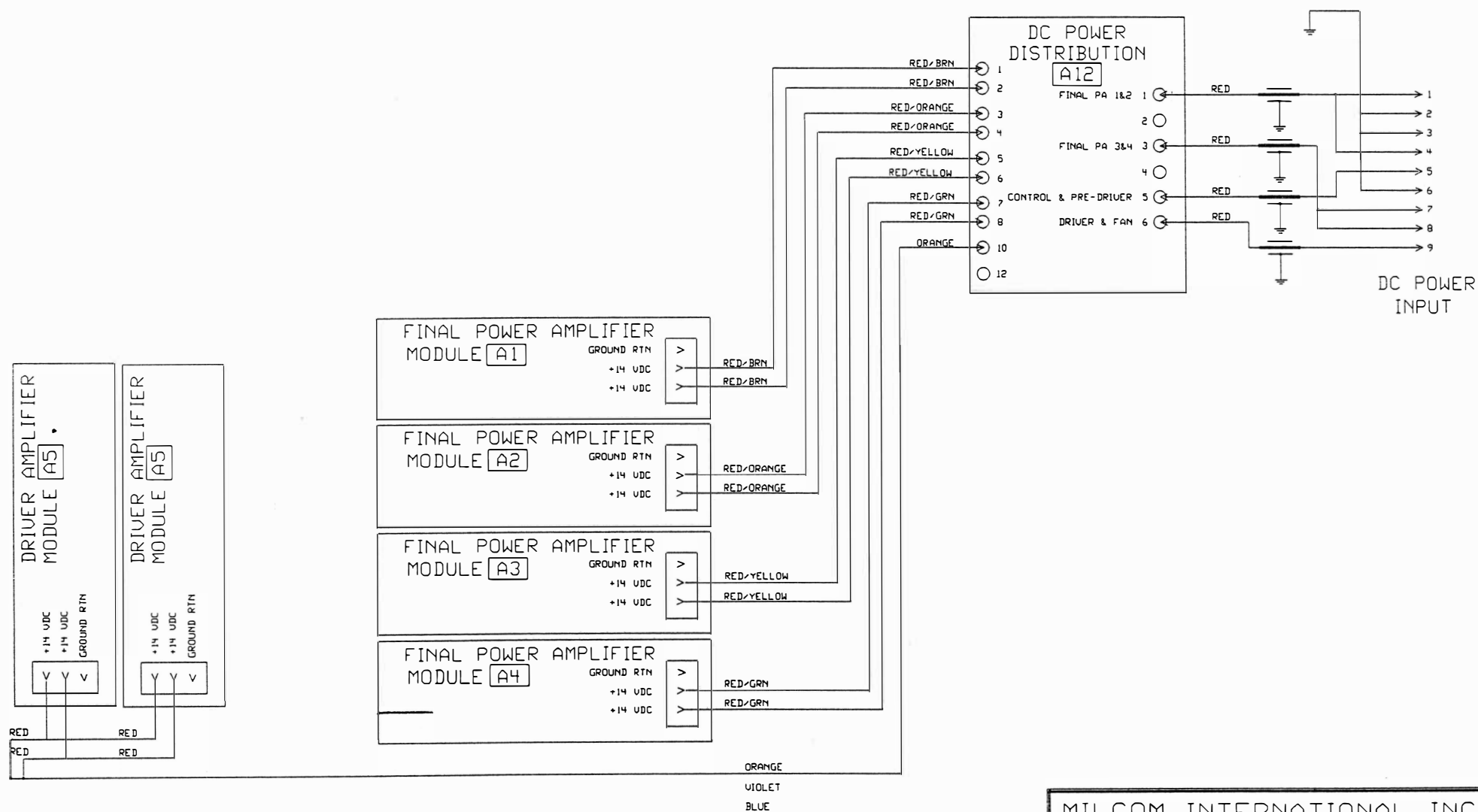
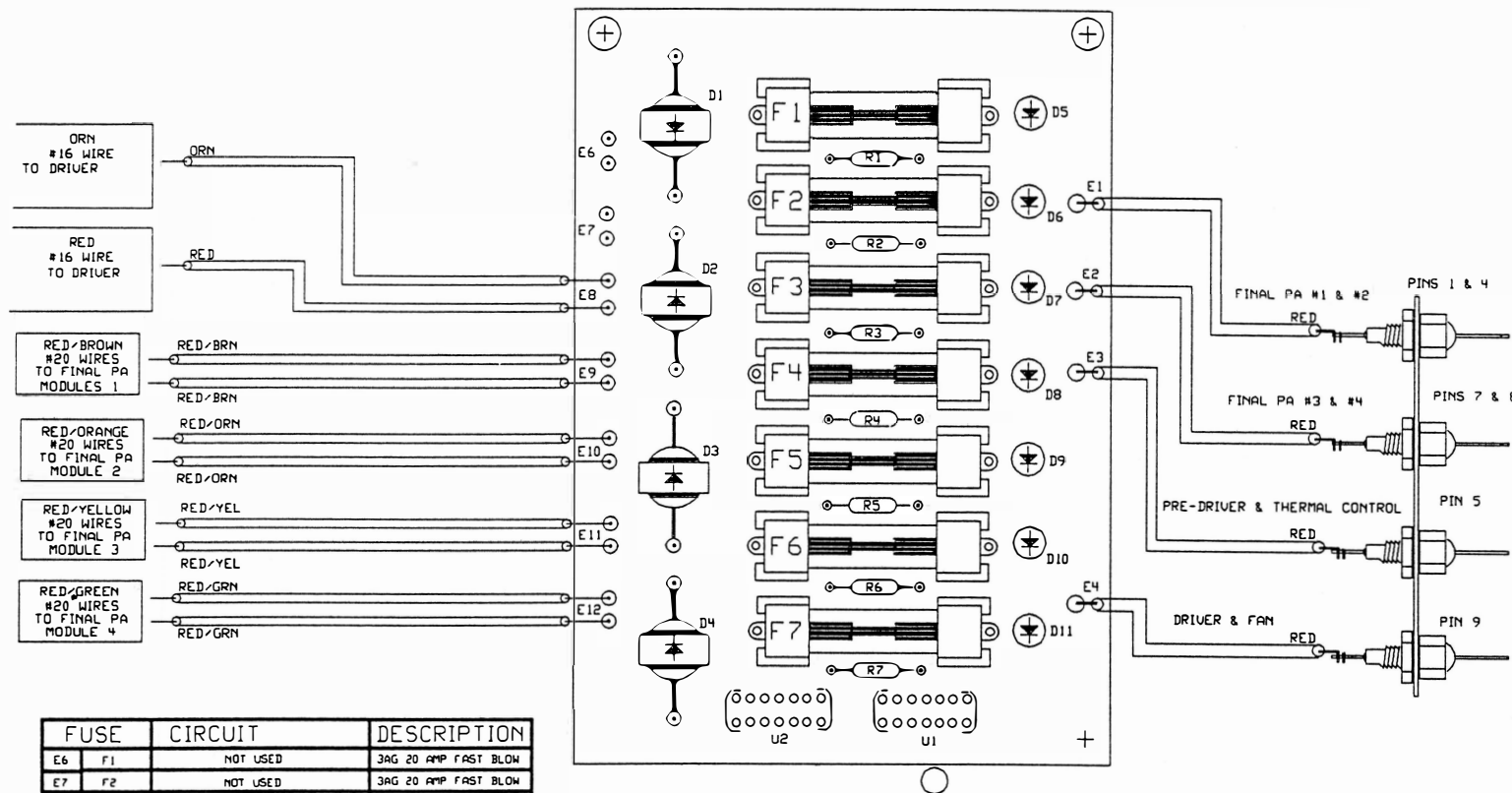


Fig. 2.4



DC POWER DISTRIBUTION AND FUSE BOARD
PICTORIAL & CONNECTIONS

MILCOM INTERNATIONAL Milcom 10891 CAPITAL AVE GARDEN GROVE, CA 92640	
SCHEMATIC DIAGRAM	
DESCRIPTION	OUTLINE DRAWING - DC DISTRIBUTION BOARD
USED ON	150 WATT, 900 MHz AMPLIFIER
CIRCUIT DESCRIPTION NO	N/A
DRAWN BY	L LE
DATE	01-13-93
PCB PN	240-083
REV	E
TDS 950-129	REV: A

SECTION III

PRINCIPAL OF OPERATION

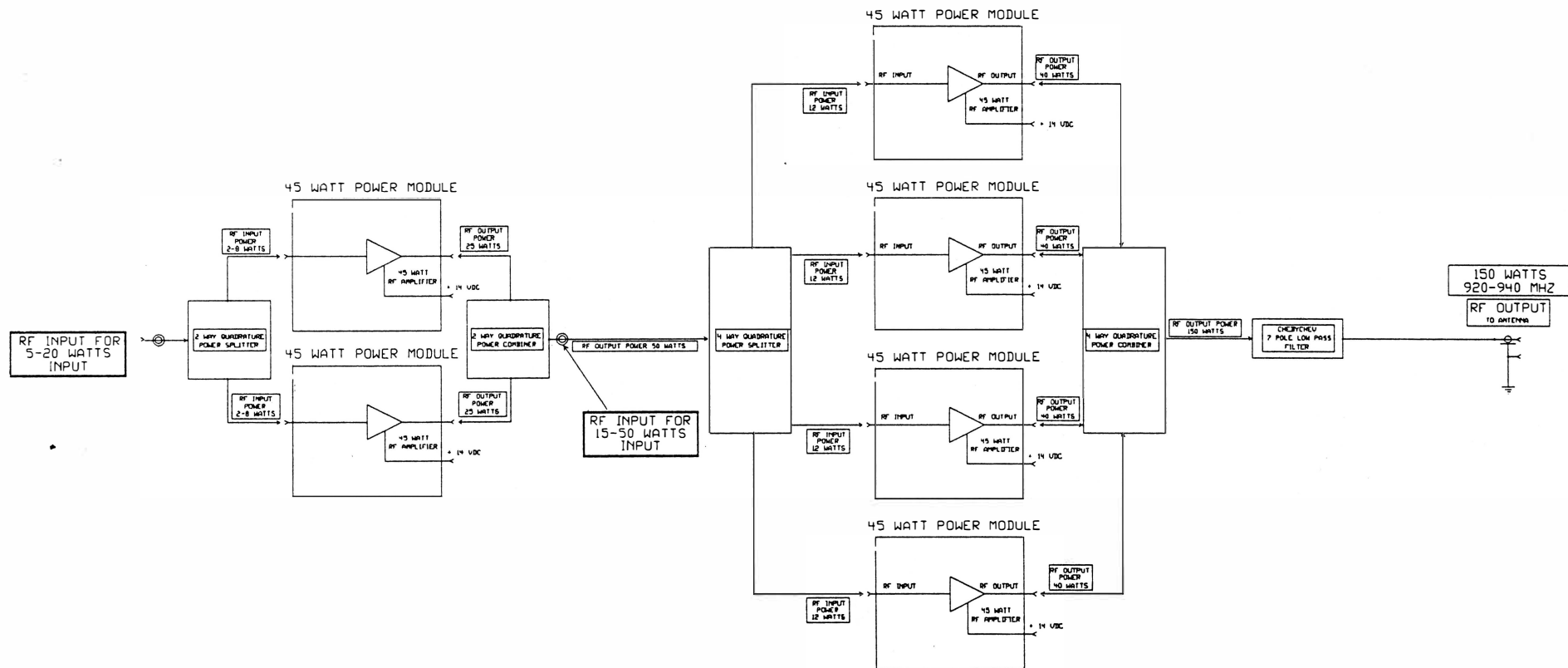
3.1 Overall Technical Description

This amplifier is intended for trunking and conventional repeater applications requiring high duty cycles. It consists of three stages of amplification followed by a 7 pole low pass filter and associated control circuitry. RF power from the final amplifier stages is combined through the 2 way combiner. Figure 3.0 shows a Functional Block diagram of the 150 Watt amplifier half Model P15-15L1. Figure 3.1 shows a simplified block diagram of the amplifier Model No. P25-2L1-C8.

The pre-driver RF module is a MHW 820 Hybrid power amplifier providing approximately 20 dB of power gain. This stage supplies 15 Watts of input power to the driver amplifier. The driver stage provides 35 to 40 Watts to the 2 Way power splitter and this power is divided equally between the 2 final amplifier stages. Each final amplifier stage provides 150 Watts to the 2 Way quadrature combiner resulting in 250 Watts of RF output power. Rigid line coax cable and double shielded Teflon cable are used for all high power RF interconnections.

The DC distribution board terminates and fuses the incoming DC voltage. Reverse-polarity protects and distributes this voltage to the modular sub-assemblies.

More detailed information on the modules in this amplifier can be found in their individual technical descriptions.

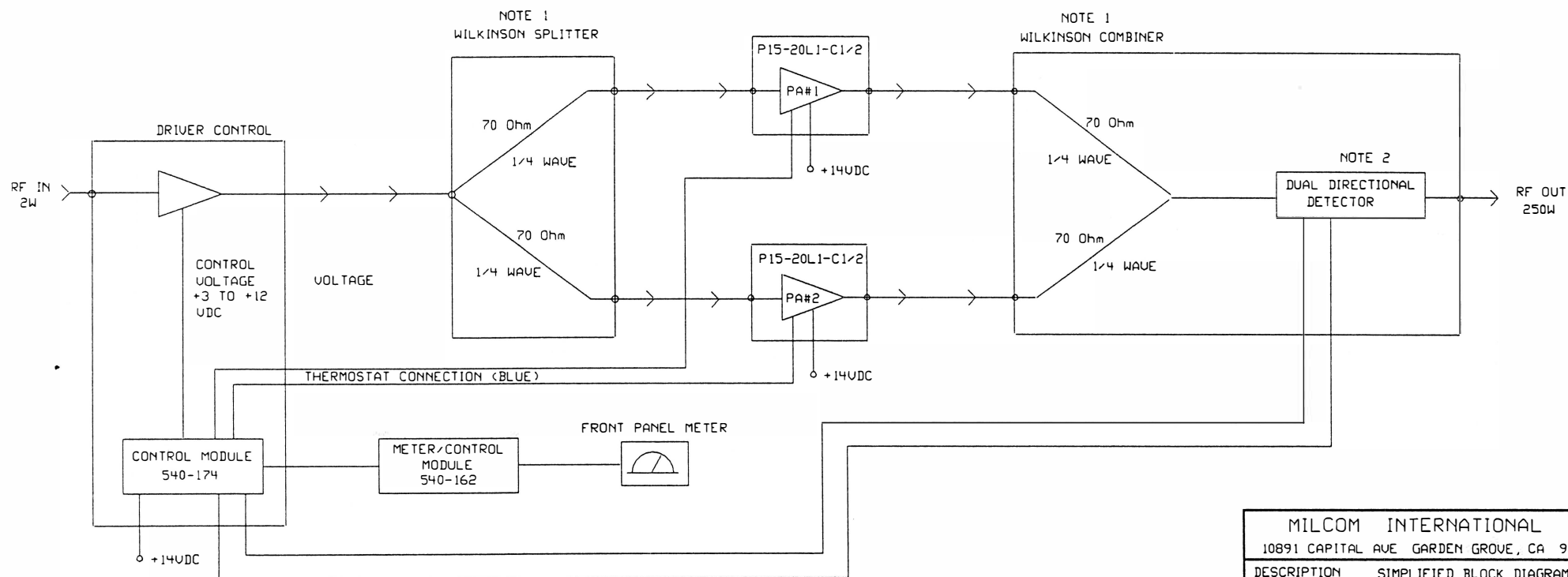


FUNCTIONAL BLOCK DIAGRAM
150 WATT 920-940 MHZ +14 VDC
FM RF POWER AMPLIFIER

Fig. 3.0

MILCOM INTERNATIONAL	
10991 CAPITAL AVE GARDEN GROVE, CA 92640	
SCHEMATIC DIAGRAM	
DESCRIPTION: FUNCTIONAL BLOCK DIAGRAM	
USED ON: RM SERIES, GS STAND PRODUCT	
MODULE ASSEMBLY NO	
CIRCUIT DESCRIPTION NO	
DRAWN BY: LYN H LE	DATE: 12-22-82
PCB PM	REV
TDS 950-118	REV A

SIMPLIFIED BLOCK DIAGRAM



NOTES

- 1 BOTH SPLITTER & COMBINER ARE LOCATED IN THE MODULE LOCATED ON THE REAR DOOR
- 2 ON EARLY MODELS, THE DUAL DIRECTIONAL DETECTOR WAS LOCATED ON THE OUTSIDE REAR DOOR ON THE LATER MODELS, IT IS LOCATED INSIDE THE COMBINER/SPLITTER MODULE

MILCOM INTERNATIONAL	
10891 CAPITAL AVE GARDEN GROVE, CA 92643	
DESCRIPTION	SIMPLIFIED BLOCK DIAGRAM
USED ON	KW SERIES, C8 STAND PRODUCT
DRAWN BY	LINH U LE
DATE	12-23-92
TDS	950-127
REV:	

Fig. 3.1

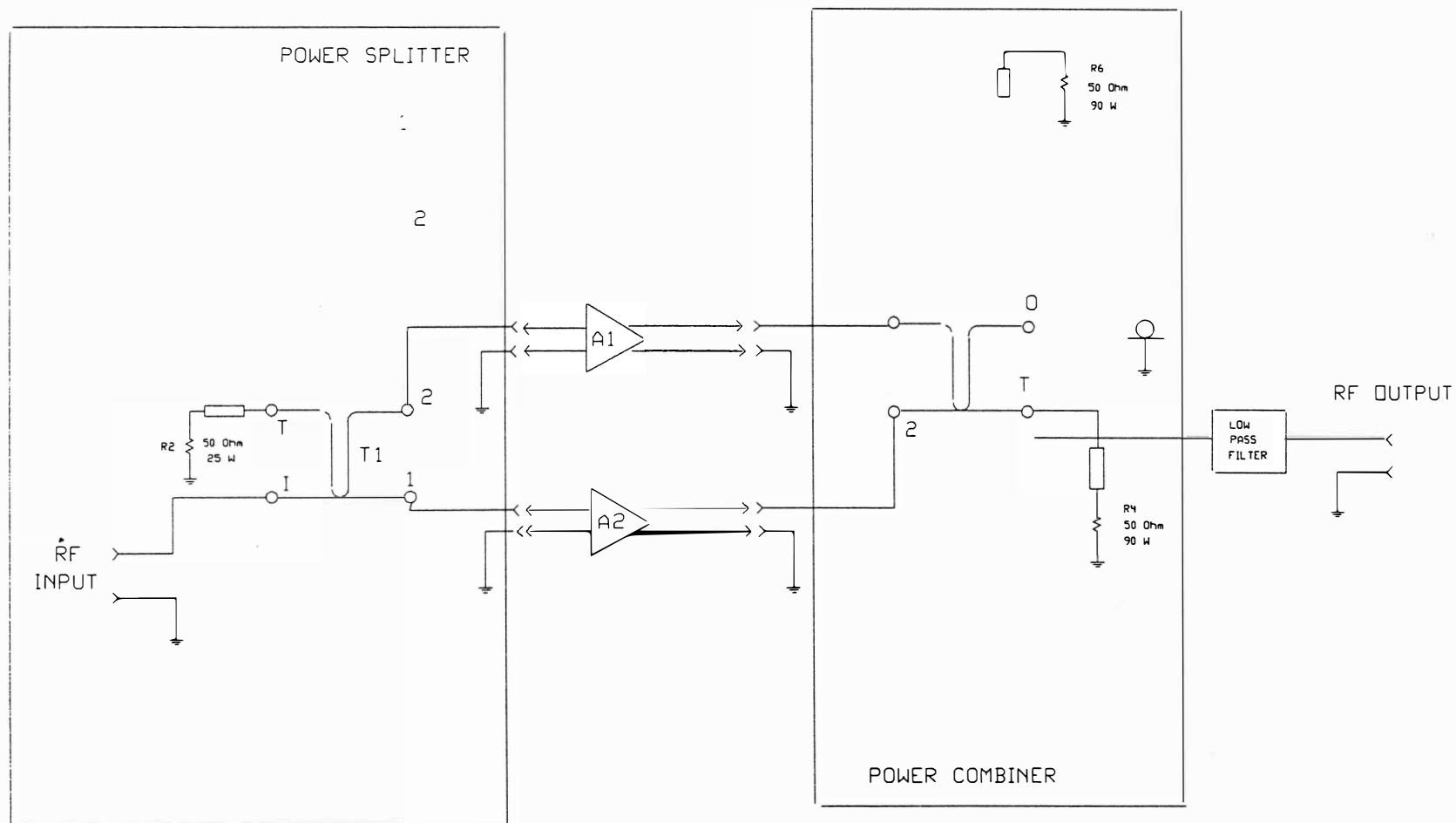
3.2

900 MHz, 2 WAY POWER SPLITTER & COMBINER

The power splitter and power combiner are designed utilizing hybrid WIRELINE. This method offers the advantage of greater isolation between power amplifier modules, the source and the load. This combiner is unique in that approximately 3 dB of the power reflected from the output load is absorbed in the port termination resistors, R1 and R2. This feature makes the amplifier unconditionally stable under almost all mismatch conditions and virtually immune to damage due to mismatches on the output. Figure 3.2 shows a schematic diagram of the 2-Way Power Splitter & Combiner.

The input power splitter, A8, consists of T1. T1 divides the input power, 35 to 40 Watts, equally between A1 and A2. The amplifier modules, A1 through A2 therefore receive about 15 Watts each at their input terminal. A 180 degrees phase shift occurs between alternate modules. A1 is 180 degrees out of phase with A2.

The output power combiner, A9, consists of T1. Each amplifier module, A1 through A2, produces 45 to 50 Watts. The power output of A1 and A2 is combined by T4 resulting in 90 Watts of power output. The combiner also shifts the phase of the amplified signals such that 0 degrees phase difference results at the output of the power combiner.



LEGEND

T = TERMINATION PORT (50 Ohm)
 1 = INPUT PORT (RF PWR IN)
 0 = OUTPUT PORT (RF PWR OUT)
 1 & 2 = LOAD OR SOURCE PORTS

MILCOM INTERNATIONAL Milcom 10891 CAPITAL AVE GARDEN GROVE, CA 92640	
SCHEMATIC DIAGRAM	
DESCRIPTION 2 WAY POWER SPLITTER & POWER COMBINER	
MODULE ASSEMBLY NO	
CIRCUIT DESCRIPTION NO	
DRAWN BY R. HEILMAN	DATE 01-12-93
PCB PM	REV
TDS	REV: A

PRODUCT	ASSEMBLY REFERENCE NO
	AB, A9
	AB, A9
	AB, A9

Fig. 3.2

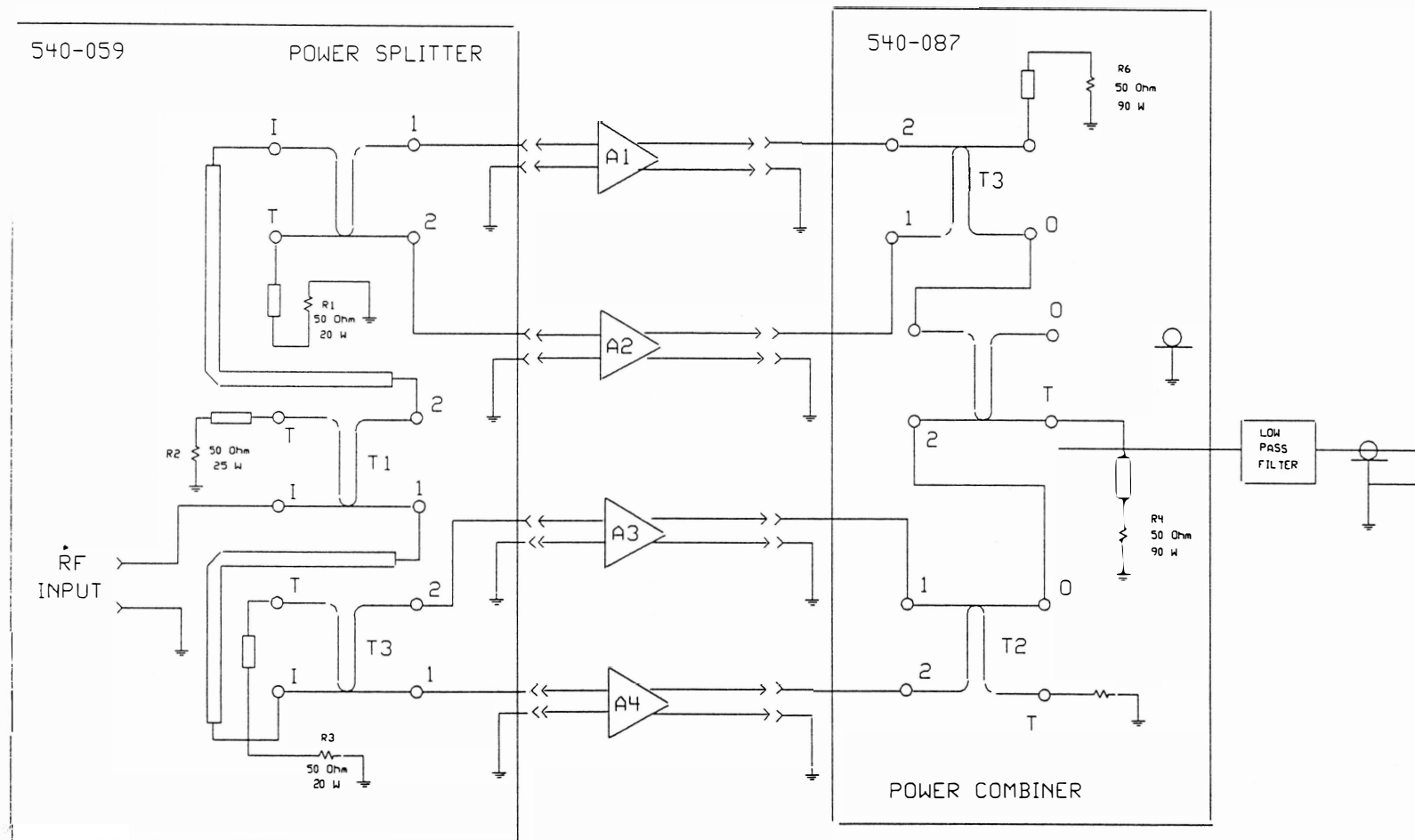
3.3

900 MHz, 4 WAY POWER SPLITTER & COMBINER

The power splitter and power combiner are quadrature designs utilizing hybrid WIRELINE. This method offers the advantage of greater isolation between power amplifier modules, the source and the load. This combiner is unique in that approximately 3 dB of the power reflected from the output load is absorbed in the port termination resistors, R1,R2,R3,R4,R5 and R6. this feature makes the amplifier unconditionally stable under almost all mismatch conditions and virtually immune to damage due to mismatches on the output. Figure 3.3 shows a schematic diagram of the 4-Way Power Splitter & Combiner.

The input power splitter, A8 consists of T1, T2, and T3. T1 divides the input power, 48 to 54 Watts, equally between T2 and T3. T2 and T3 again divide the power equally between A1, A2, and A4. The amplifier modules, A1 through A4 therefore receive about 12 Watts each at their input terminal. A 90 degrees phase shift occurs between alternate modules. A1 is 90 degrees out of phase with A2 and A3 is 90 degrees out of phase with A4. The module pair A1 and A2 is 90 degrees out of phase with the module pair A3 and A4.

The output power combiner, A9 consists of T4,T5 and T6. Each amplifier module, A1 through A4, produces 40 to 45 Watts. The power output of A1 and A2 is combined by T6 and the power output of A3 and A4 is combined by T5. The power combined by T5 and T6 is then combined by T4 resulting in 150 to 170 Watts of output power. The combiner also shifts the phase of the amplifier signals such that 0 degrees of phase difference results at the output of the power combiner.



LEGEND

T = TERMINATION PORT (50 Ohm)
 I = INPUT PORT (RF PWR IN)
 O = OUTPUT PORT (RF PWR OUT)
 1 & 2 = LOAD OR SOURCE PORTS

MILCOM INTERNATIONAL Milcom 10891 CAPITAL AVE GARDEN GROVE, CA 92640	
SCHEMATIC DIAGRAM	
DESCRIPTION 4 WAY POWER SPLITTER & POWER COMBINER 150 WATTS RF AMPLIFIER 806 TO 890 MHz	
MODULE ASSEMBLY NO 540-059 & 540-087	
CIRCUIT DESCRIPTION NO	
DRAWN BY LINH LE	DATE 01-12-93
PCB PN 240-059 & 240-087	REV
TDS 950-136	REV: A

PRODUCT	ASSEMBLY REFERENCE NO
P15-2L1	A8, A9
P15-05L1	A8, A9
P15-15L1	A8, A9

Fig. 3.3

3.4

DC DISTRIBUTION BOARD

The DC distribution board serves several functions. It provides a termination point for the incoming high current DC voltage, a convenient mounting for the DC power line fuses, a mounting for the reverse protection diodes and a distribution point for DC power to the modular sub-assemblies.

The compartment where the distribution board is mounted receives high current DC voltage from J101 through four RFI feed thru filters FL1 through FL4. This voltage is terminated at terminal board TB1. Figure 3.4 shows a schematic diagram of the DC distribution board.

Diodes CR1 through CR4 protect the amplifier from damage due to reverse polarity and internal shorts. Each D.C. distribution board has seven 15 ampere fuses installed. These fuses are not intended to protect the RF power transistors from damage due to mismatch or over drive.

The eyelet terminals on TB2 are used to distribute the DC power to the amplifier and control modules.

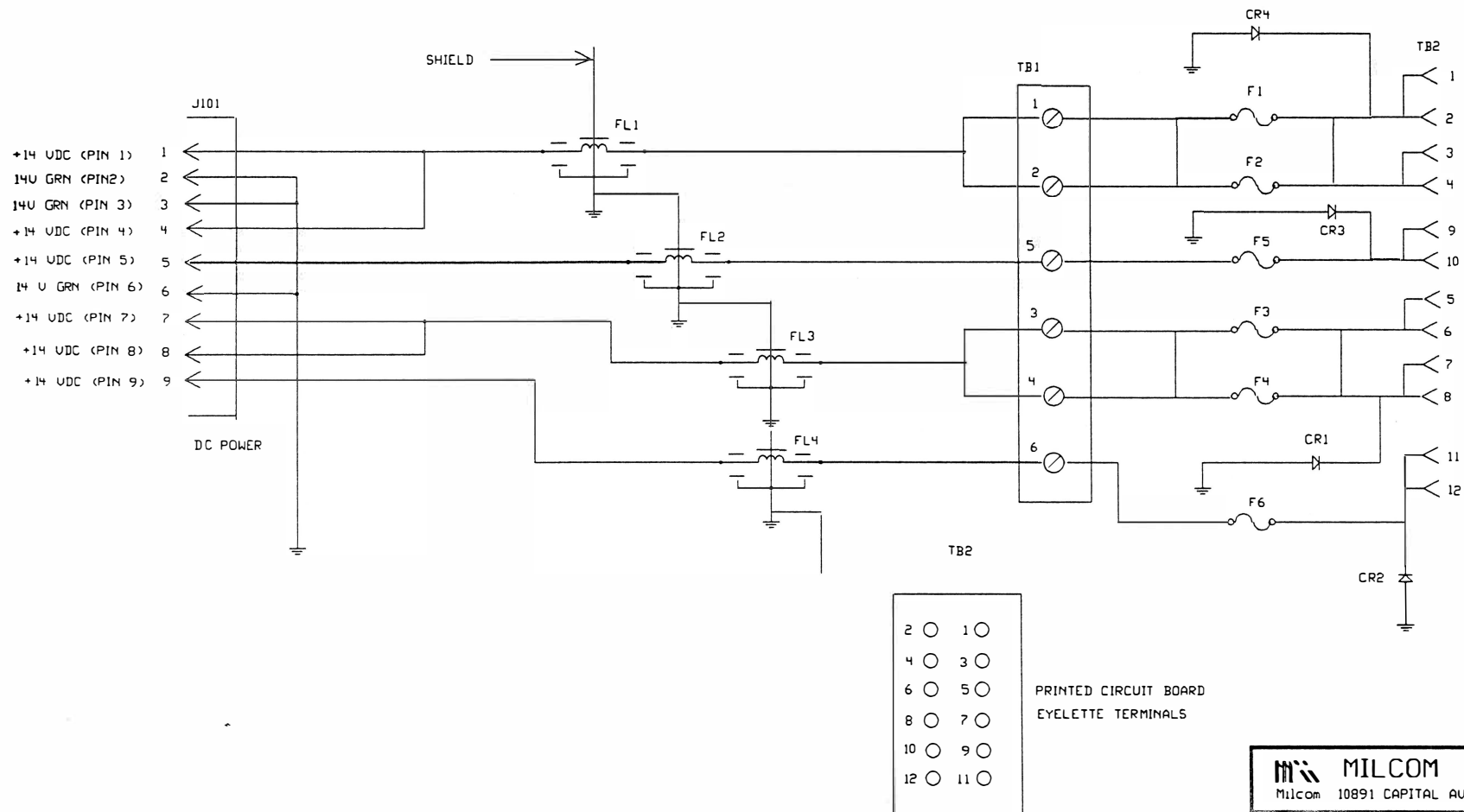


Fig. 3.4

MILCOM INTERNATIONAL Milcom 10891 CAPITAL AVE GARDEN GROVE, CA 92640	
SCHEMATIC DIAGRAM	
DESCRIPTION	DC DISTRIBUTION BOARD & EXTERNAL CONTACTS
USE ON	
MODULE ASSEMBLY NO	540-083A
CIRCUIT DESCRIPTION NO	
DRAWN BY	L LE
DATE	01-13-93
PCB PH	REV
TDS	950-138
REV: A	

This module is common to all 14V 900 MHz RF power amplifiers. It is used as a driver and final amplifier. The only difference between the driver module and the final amplifier modules is a variable capacitor, C2, used in the driver module for minimizing the input VSWR when the input power is greater than 5 Watts, and a 1000pF chip capacitor on the T4 trace. This capacitor is located below the 56pF chip capacitor also on the T4 trace. Figure 3.5 shows a schematic diagram of the 45 Watt, 900 MHz Common Base Amplifier.

DC voltage is fed to the collector through tuning stub T4. The exact length of this tuning stub is adjusted by changing the location of C14. L3 and L4 along with C12, C7, C8, C13 and C10 decouple the DC supply line from the Collector matching circuitry. C11 is a DC blocking capacitor.

The collector load impedance is matched to 50 ohms through metal clad mica capacitor C5, porcelain chip capacitor C6, air variable capacitor C9; Microstrip transmission lines are printed on Teflon Glass circuit board.

The emitter is matched to 50 ohms through metal clad mica capacitors C3 and C4, air variable capacitor C2, microstrip transmission line transformer T1 and microstrip stub T2. The DC return path to the emitter is through T1 and T2.

The circuit board utilizes plated through holes for ground return and low inductance base contacts. Ground connections to the combiner and splitter are made through mechanical contact with the aluminum spacer plates. This method has proven to be highly reliable while at the same time simplifying manufacturing and field replacement. DC contact is made through two pins on J1.

Because component placement is critical at these frequencies, amplifier modules are manufactured on an assembly fixture to assure correct component placement and uniformity. Therefore, field repair of these amplifier modules is not recommended.

Alexander

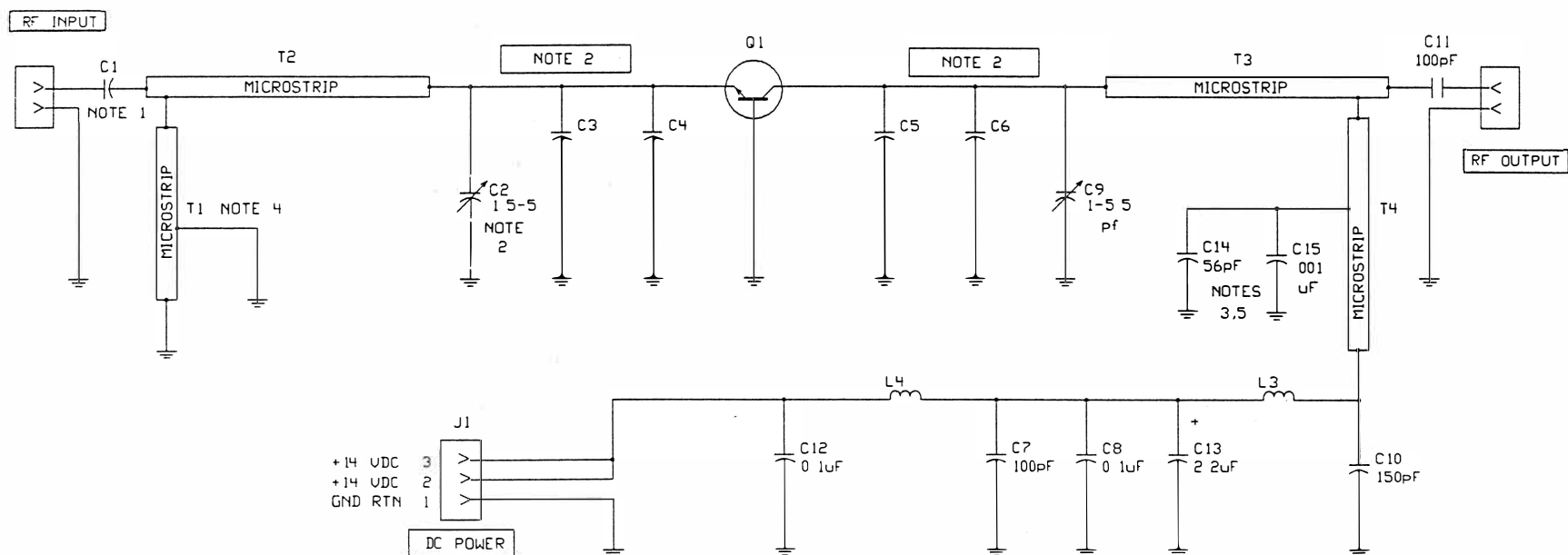


Fig. 3.5

FREQUENCY SELECTABLE CAPACITORS						
MODULE PN	FREQ	C3	C4	C5	C6	C9A
540-061J45	780-806 MHz	12	15	15	15	2.2
540-061K45	806-890 MHz	12	10	10	12	N/A
540-061L45	915-940 MHz	10	10	10	12	N/A
540-061M45	940-960 MHz	10	10	10	10	N/A

NOTES

- 1 C1 IS USED ON DRIVER MODULES ONLY
- 2 C2 IS USED ON DRIVER AND REPLACEMENT PA MODULES ONLY
- 3 LOCATION OF C14 IS DIFFERENT FOR THE 850-890 AND 935-940 MHZ RANGES
LOCATION IS FACTORY ADJUSTED FOR MAXIMUM POWER OUTPUT
- 4 LOCATION OF JUMPER IS DIFFERENT FOR THE 850-890 AND 935-940 MHZ RANGES
LOCATION IS FACTORY ADJUSTED FOR MINIMUM REFLECTED POWER

MILCOM INTERNATIONAL	
10891 CAPITAL AVE GARDEN GROVE, CA 92640	
SCHEMATIC DIAGRAM	911-061
DESCRIPTION	45 WATT RF POWER AMPLIFIER MODULE
USED ON	ALL 806 TO 960 MHZ 14VDC RF POWER AMPLIFIERS
MODULE ASSEMBLY NO	540-061
CIRCUIT DESCRIPTION NO	TD 112
FILE NAME	45W800SC
DRAWN BY	LIKH LE
DATE	01-11-93
PCB PN	240-061
REV	F
TDS : 950-134 REV : A	

3.6

15 WATT, 16 dB GAIN HYBRID POWER AMPLIFIER

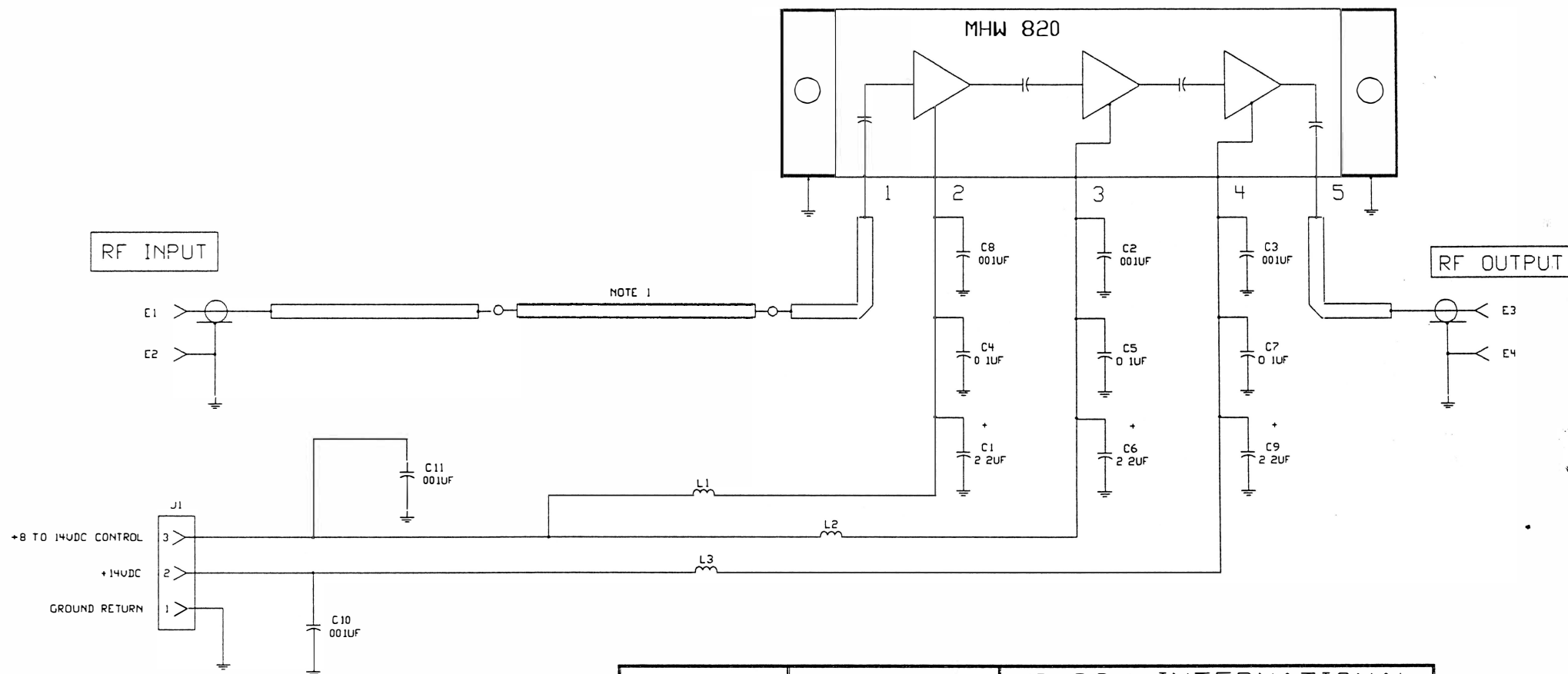
This amplifier module utilizes a 15 Watt hybrid power amplifier module manufactured by Motorola Semiconductor. The module is mounted directly to the heat sink with its leads soldered to a circuit board where DC supply voltage and RF input and output connections are made. Figure 3.6 shows a schematic diagram of the Hybrid Power Amplifier.

DC supply line isolation is achieved through L1, L2, L3, C1, C2, C3, C4, C5, C6, C7, C8, C9, C10 and C11.

RF input and output connections are made to microstrip transmission lines connected at terminals 1 and 5.

14 Volts is supplied to the final amplifier stage through hybrid amplifier pin number 4. This voltage enters the circuit board at J1 pin 2.

A variable voltage is supplied to the pre-amplifier and driver amplifier stages on the hybrid amplifier pin number 3. This voltage is varied in order to adjust amplifier power output.



NOTES

1 FOR POWER INPUT LEVELS BELOW 500 MW THE ATTENUATOR IS BYPASSED

MILCOM INTERNATIONAL		
PRODUCT	ASSEMBLY REFERENCE NO	
P18-02K1	P18-05K1	A6
P12-02L1	P12-05L1	A6
P15-02H	P15-05H	A6
P15-2L1		A6
		SCHEMATIC DIAGRAM 902-108
		DESCRIPTION 20 WATT HYBRID RF POWER MODULE
		USED ON ALL 120 & 150 WATT 806-960 MHZ RF POWER AMPLIFIERS
		MODULE ASSEMBLY NO 540-071
		PRINTED CIRCUIT BOARD LAYOUT NO 902-102
		BILL OF MATERIALS DWG NO 902-110
		CIRCUIT DESCRIPTION NO TD 116
		20W800HS DWG

TDS 950-128

Fig. 3.6



3.7

7 POLE LOW PASS FILTER

This seven pole low pass filter is a Chebychev 0.1 dB ripple design. It attenuates all harmonics by a minimum of 35 dB. Figure 3.7 shows a schematic diagram of the filter.

The inductors, L1, L2 and L3, are 0.020 brass stampings for minimum loss and high repeatability.

Capacitors, C1, C2, C3 and C4 are printed on Teflon glass circuit board.

Even though this filter only has 0.1 to 0.2 dB of loss it is attached directly to the main heat sink to avoid heat build up.

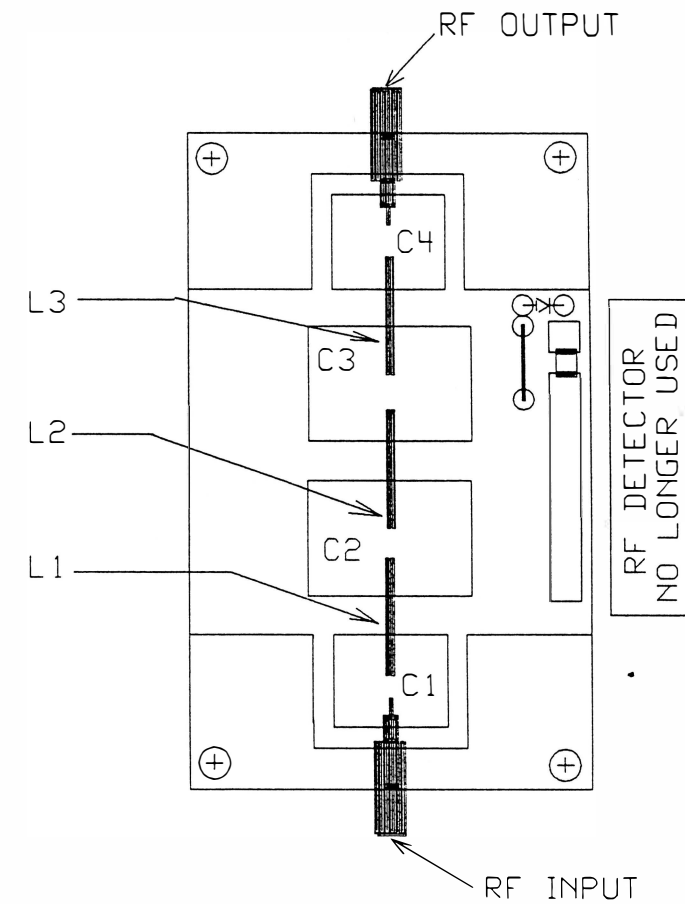
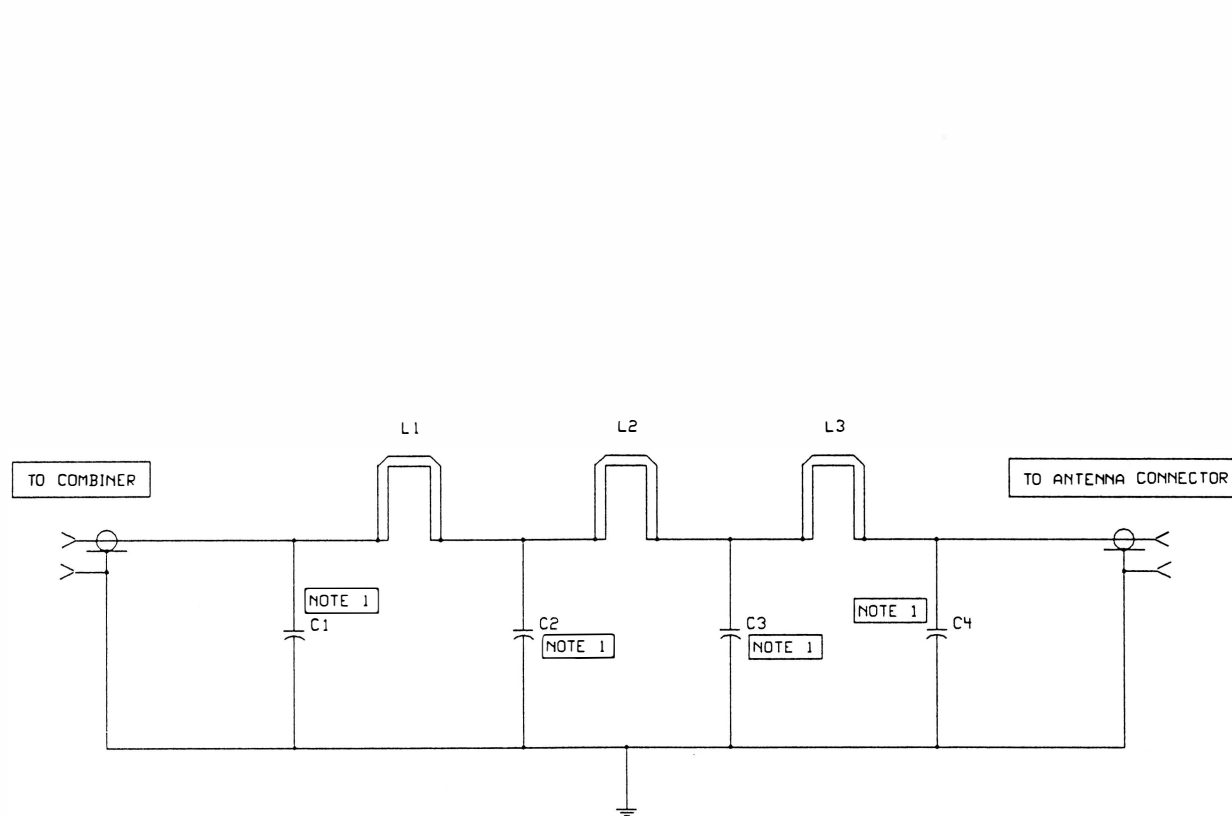


Fig. 3.7

NOTES

1 C1,C2,C3,C4 ARE PRINTED CIRCUIT BOARD CAPACITORS

PRODUCT	ASSEMBLY REFERENCE NO	MILCOM INTERNATIONAL	
		SCHEMATIC DIAGRAM 902-103	
P15-05L1	A12	DESCRIPTION	7 POLE LOW PASS FILTER 890 MHZ C/O
P25-05L1	A12	USED ON	ALL 806 TO 960 MHZ RF AMPLIFIERS
P25-2L1	A12	MODULE ASSEMBLY NO	540-066A
		PRINTED CIRCUIT BOARD LAYOUT NO	902-104
		BILL OF MATERIALS DWG NO	902-105
		CIRCUIT DESCRIPTION NO	TD 114
			960LPFSC

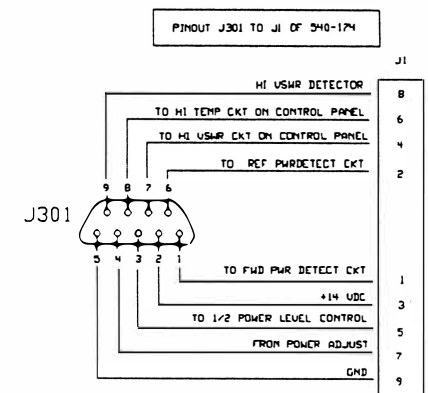
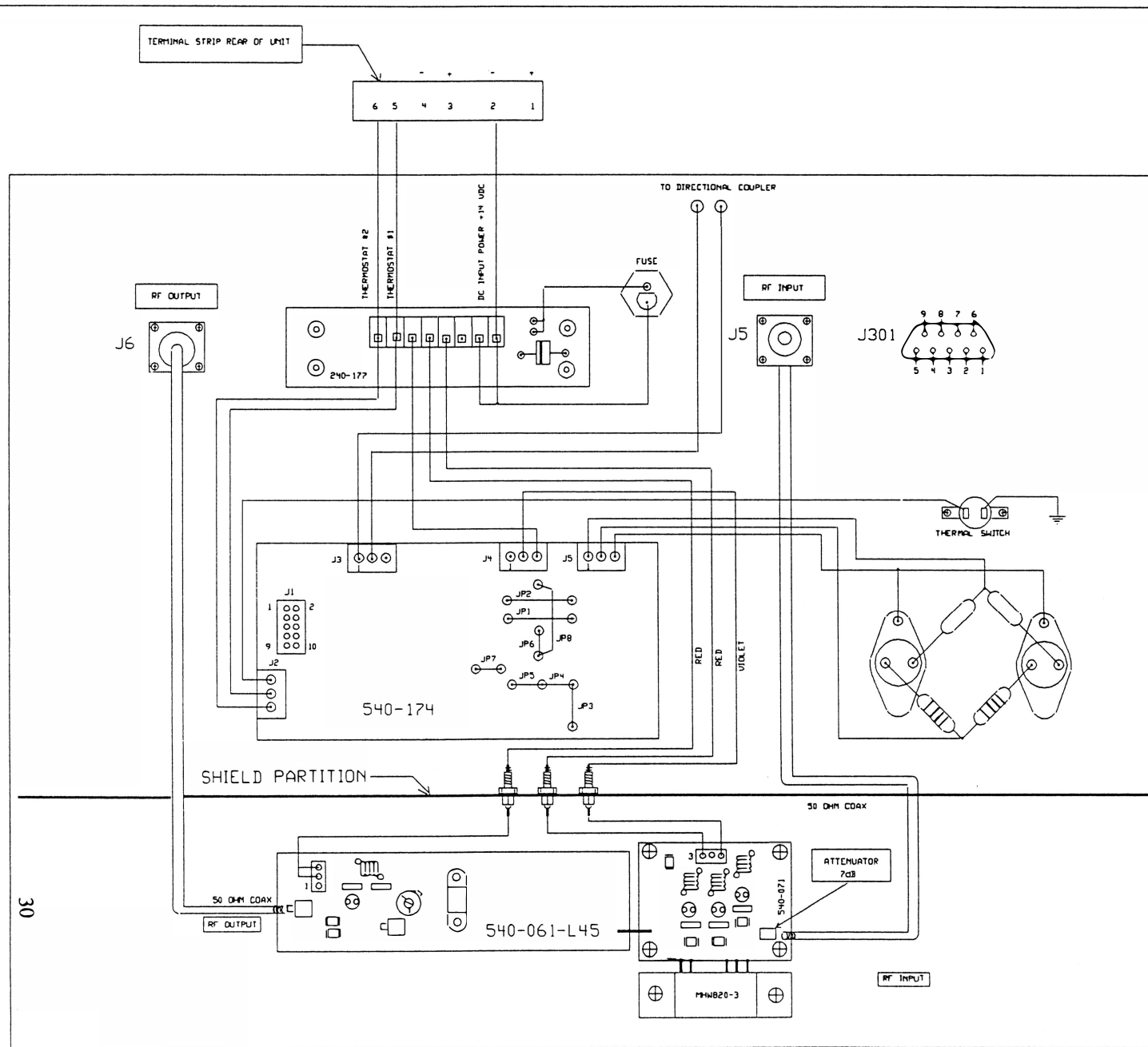


Fig. 3.8

MILCOM INTERNATIONAL	
10891 CAPITAL AVE GARDEN GROVE, CA 92640	
SCHEMATIC DIAGRAM	TDS 950-122
DESCRIPTION	DRIVER/CONTROL MODULE
USED ON	KW SERIES CB STAND PRODUCT
MODULE ASSEMBLY NO	
CIRCUIT DESCRIPTION NO	
DRAWN BY	LINK U LE
DATE	12-22-92
PCB PN	REV
TDS 950-120	REV

SECTION IV

MAINTENANCE

4.1

AMPLIFIER SERVICE PROCEDURES

Since the field adjustments are minimal, if required at all, the primary service function is that of verifying the proper operation of the amplifier and troubleshooting failures to the module level. Refer to figures 4.1 and 4.2 for all adjustment locations.

If it is necessary to verify the proper operation of the amplifier, the test setup illustrated in figure 4.3 is recommended. Care should be taken to make the RF output and input cables as short as possible. In the 450 and 512 MHz and 806 to 890 MHz frequency ranges the power output connection to the Watt meter should be no longer than 12 inches, and RG 214 or equivalent coaxial cable should be used. The power output specifications are based on power available at the power output connector and long or high-loss cables before the Watt meter may result in disagreement with the published specifications.

The transmitter/exciter the amplifier will be used with may, be substituted for the sweep oscillator and broad band power amplifier. Additionally, a spectrum analyzer is not an absolute necessity, however, the test set-up in figure 4.3 is the same as that used by the factory and duplication of it will assure accurate measurements.

A well regulated DC power supply or battery should be used as a source for the operating voltage. Power Amplifiers require a considerable amount of current and therefore the power supply used must be well regulated and free of voltage transients or damage to the amplifier may occur during on/off cycles. A battery eliminator or charger should not be used as a DC power supply since these units can surge up to 20 volts under no load conditions and damage the RF power transistors.

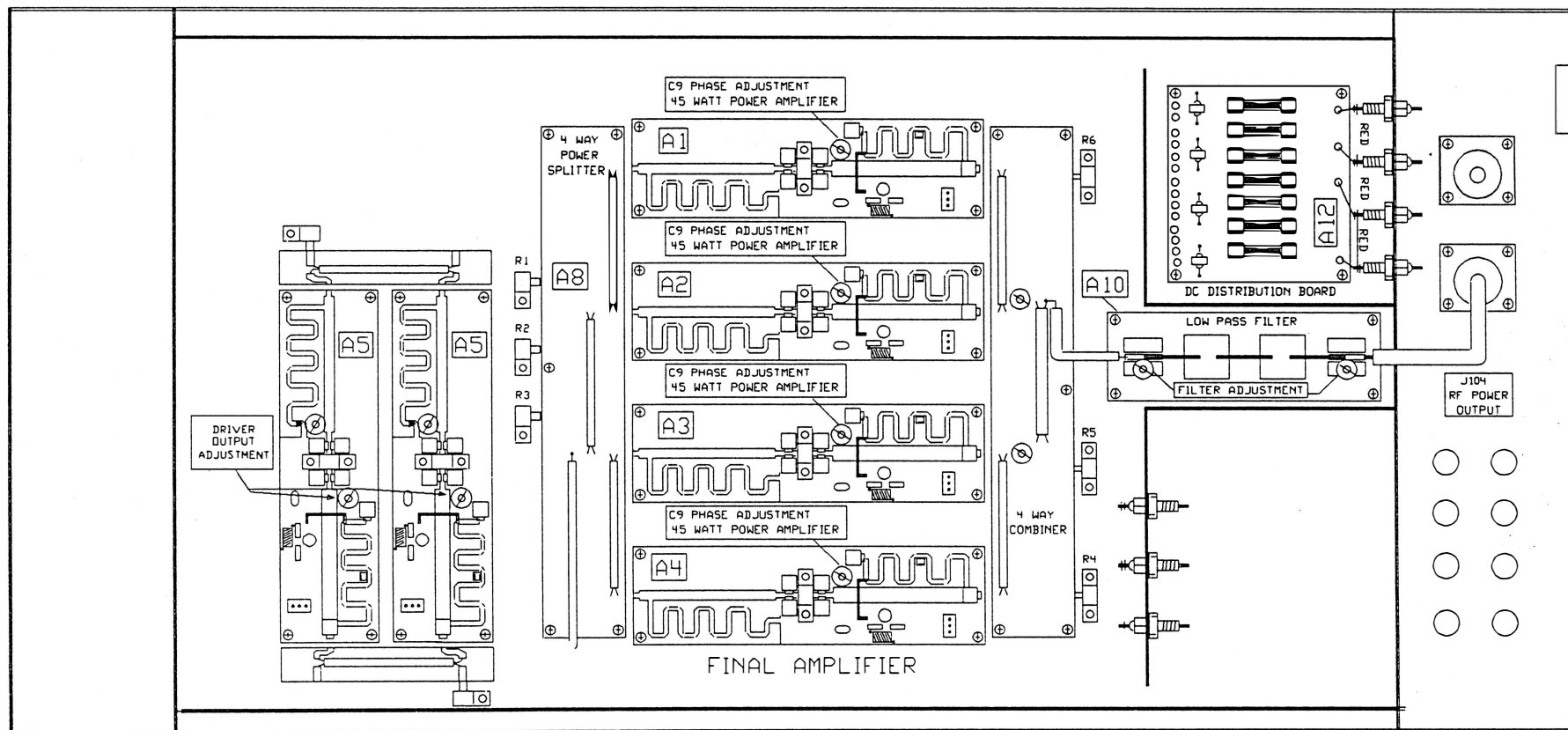
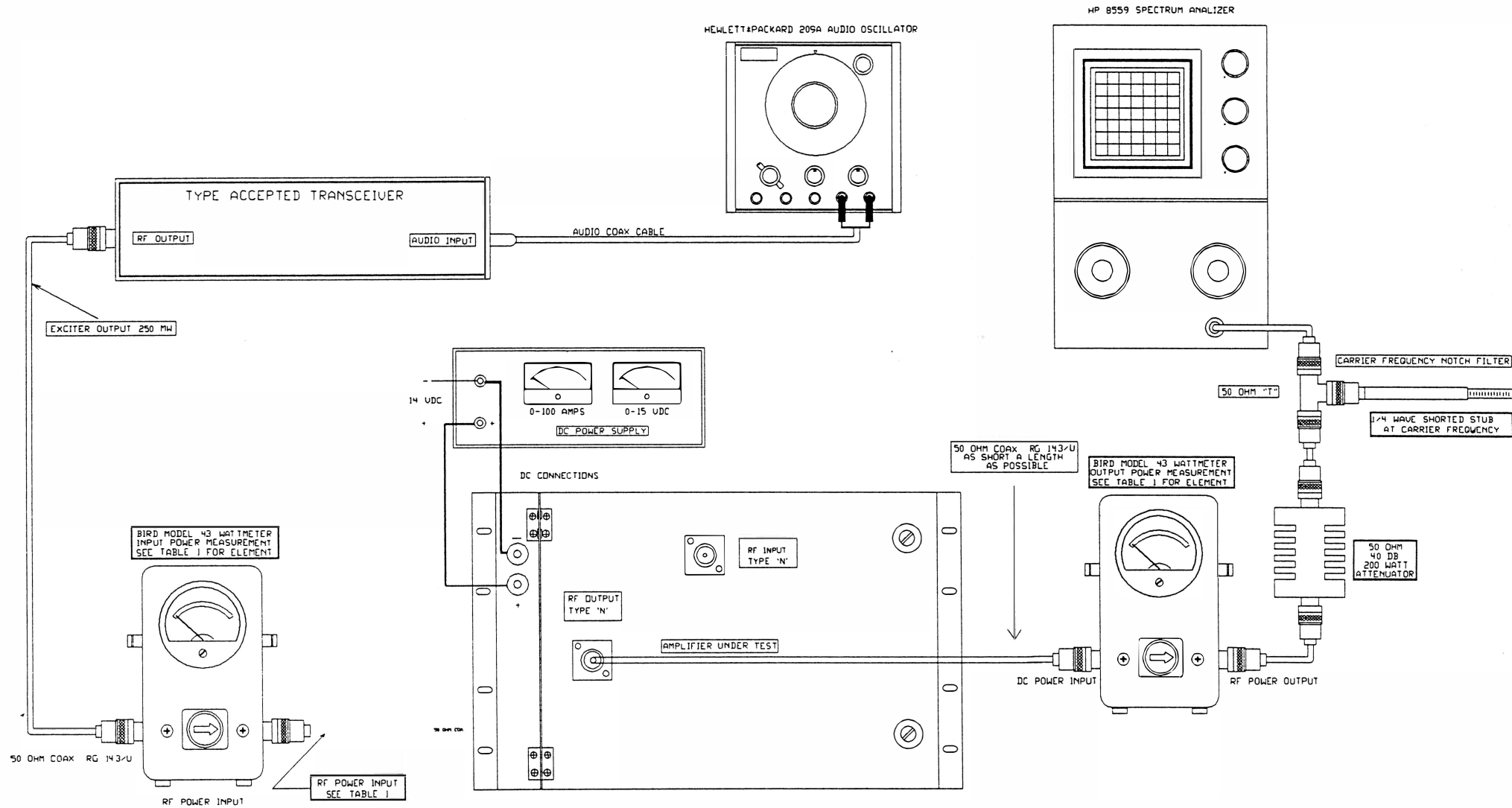


Fig. 4.1

MODULE AND ADJUSTMENT LOCATION
150 WATT 920-960 MHz +14 VDC
RF POWER AMPLIFIER





TDS 950-072

POWER AMPLIFIER TEST SETUP
MILCOM INTERNATIONAL, INC

Fig. 4.3

4.2

AMPLIFIER ADJUSTMENT INSTRUCTIONS

Applicable to the models listed below:

MODEL	FREQUENCY	POWER INPUT	VDC
P25-02L1-C1	930-940 MHz	50 mW	14
P25-05L1-C1	930-940 MHz	250 mW	14
P25- 2L1-C1	930-940 MHz	2.0 W	14
P25-15L1-C1	930-940 MHz	15 W	14

Equipment Required: See Test Set-up

STEP	ADJUSTMENT	PROCEDURE	NOTES
1.			P25-02L1-C1 and P25-05L1-C1 and P25- 2L1-C1 only
2.			P25-02L1-C1 and P25-05L1-C1 and P25- 2L1-C1 only
3.	C2 on A1	Adjust C2 for minimum reflected power at J103	P25-15L1-C1 only
4.			
5.			P25-02L1-C1 and P25-05L1-C1 and P25--2L1-C1 and P25-15L1-C1
6.			P25-02L1-C1 and P25-05L1-C1 and P25- 2L1-C1 only
7.			P25-02L1-C1 and P25-05L1-C1 and P25- 2L1-C1 only

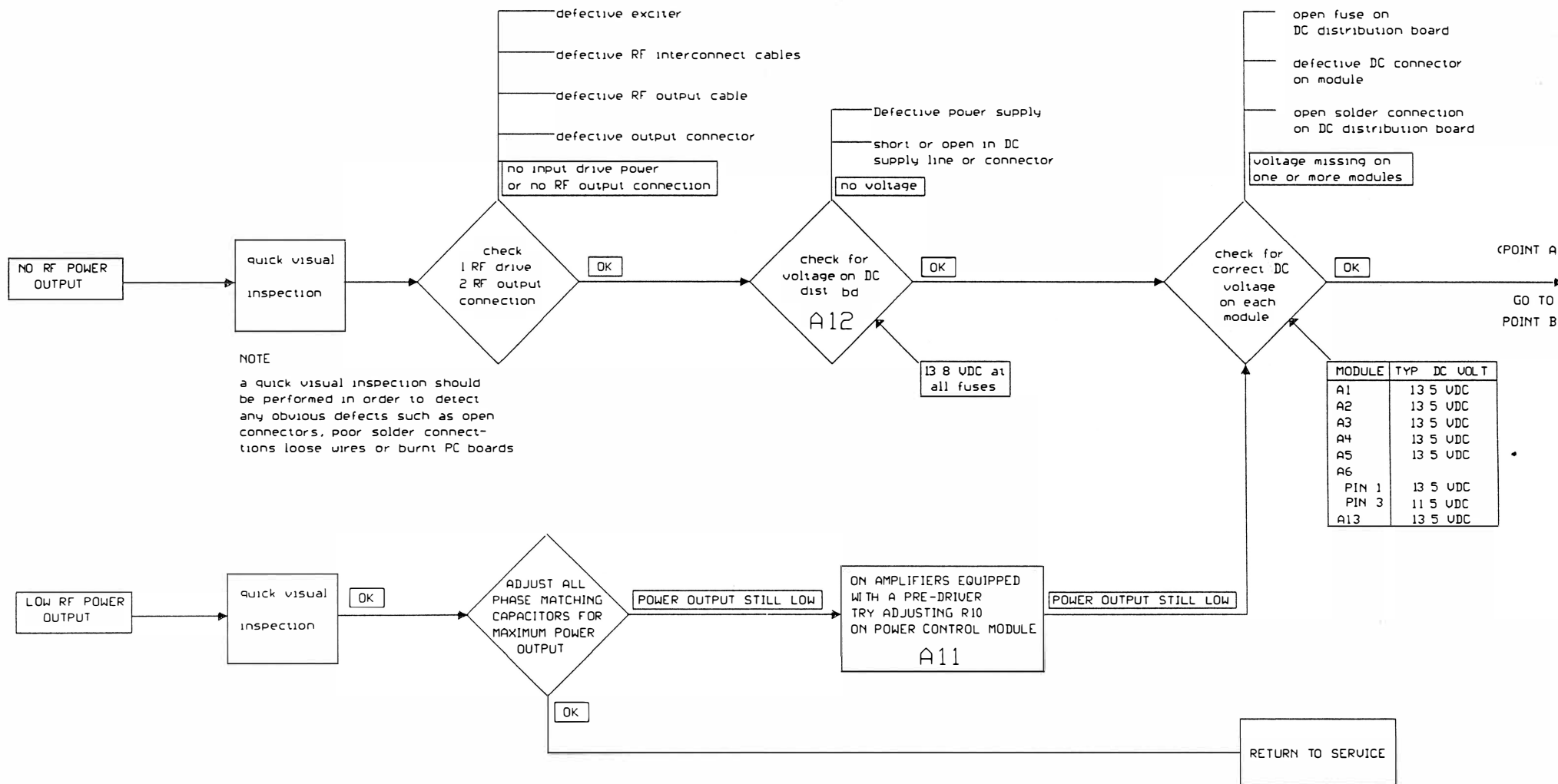


Fig. 4.4-1

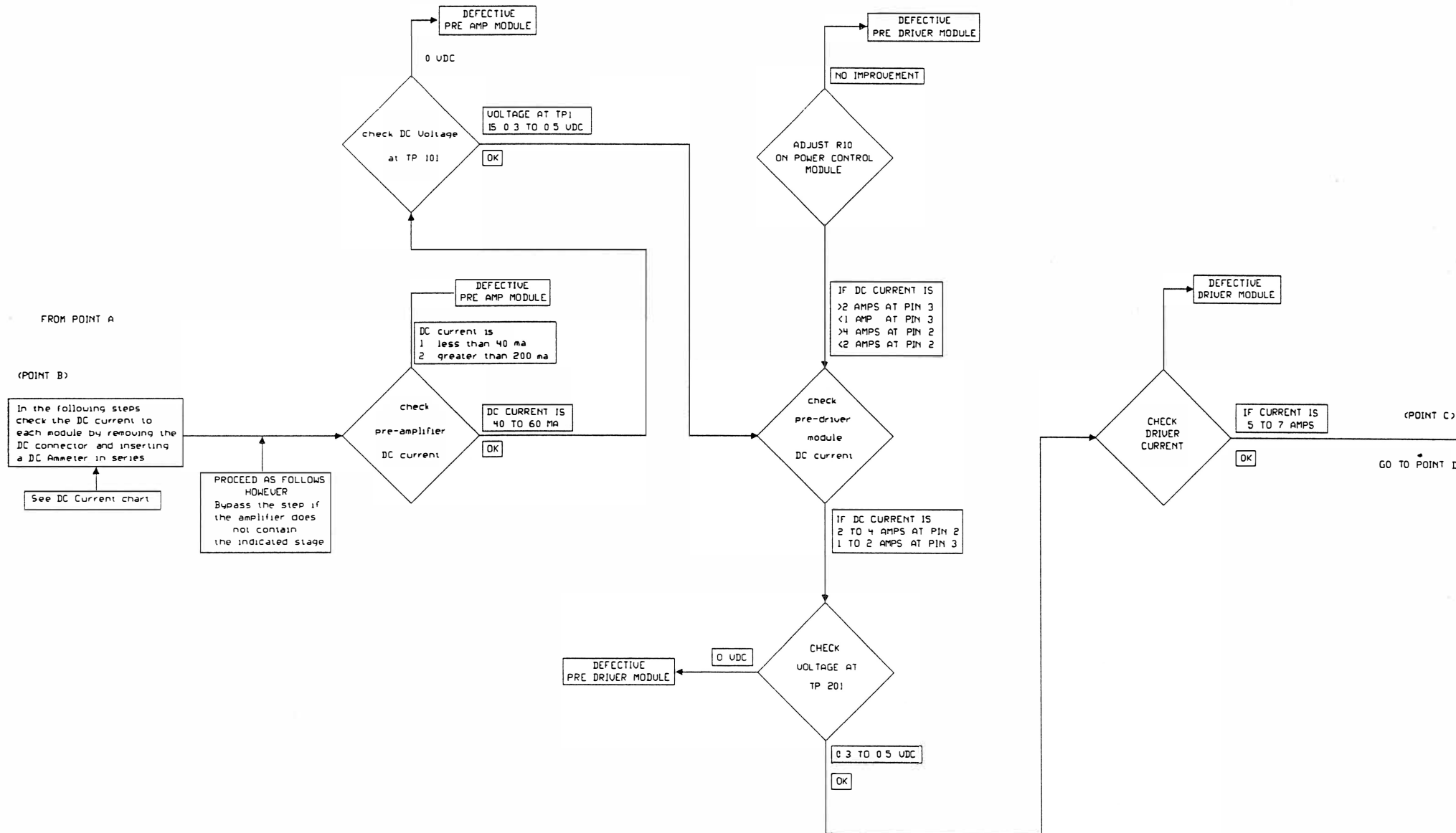


Fig. 4.4-2

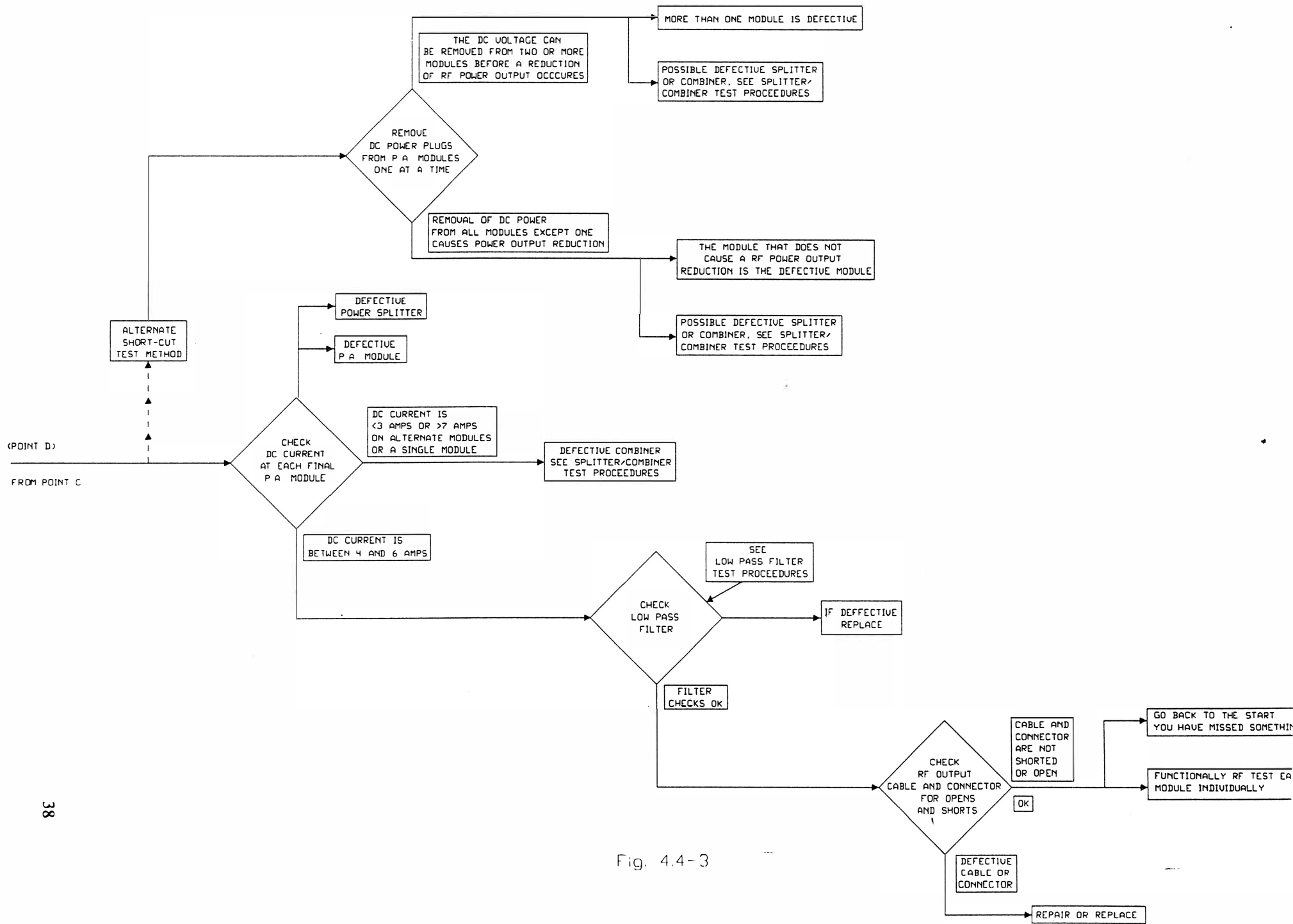


Fig. 4.4-3

SECTION V

Replacement Parts List

5.1 Introduction

This section contains the amplifier parts lists in addition to information necessary for ordering spare parts and replacement parts.

5.2 Correspondence and Ordering of Spare Parts

When ordering spare and replacement parts the user should follow the logistics procedures established by his organization. Where activities are authorized to order directly from Milcom, parts and additional service information can be obtained from:

Milcom International, Inc.
10891 Capital Ave.
Garden Grove, Calif.
92643-4953

Telephone: (714) 554-1710
Fax: (714) 554-3090

When requesting information, or ordering spare replacement parts from Milcom, the following information should be supplied:

- A. Name, Model No. and serial number of the amplifier
- B. Part number and/or stock number

5.3 Parts Supplied (BOM's)

Table 5.0 lists the major components for the following amplifier models:

P25-02L1-C1
P25-05L1-C1
P25- 2L1-C1
P25-15L1-C1

Refer to figures 5.3-1 through 5.3-9 for parts location.

TABLE 5.3-0

Major Amplifier Components

BOM NO.	REF. DESC.	PART NO.	DESCRIPTION
5.3-1	A6	540-071	15 Watt Output, 20 dB Gain Hybrid Power Amplifier
5.3-2	A1-A5	540-061	45 Watt, 900 MHz 14 VDC Common Base Amplifier
5.3-3		540-155	900 MHz 2-Way Power Splitter
5.3-4		540-155	900 MHz 2-Way Power Combiner
5.3-5		540-059	900 MHz 4-Way Power Splitter
5.3-6		540-087C	900 MHz 4-Way Power Combiner
5.3-7	A10	540-066	7 Pole Low Pass Filter, 960 MHz Cut Off
5.3-8	A12	540-083A	DC Distribution Board
		540-162	Power Meter Control Board
		540-174	Output Power Control Board

BOM 5.3-1

15 Watt Output, 20 dB Gain Hybrid Power Amplifier Part No. 540-071

2-Watt Drive

PART NO.	DESCRIPTION	QUANTITY
240-071	P.C. Board	1
195-003	Hybrid Amplifier, MHW 820 Series	1
159-009	Attenuator, 10 dB, 2 Watt *	1
161-006	Capacitor, Ceramic Chip 1000pF	4
160-003	Capacitor, Multilayer 63 V, 0.1uF	3
164-007	Capacitor, Electrolytic 50 V, 2.2uF	3
157-003	Resistor, Chip 1/8 Watt, 10 Ohms	2
171-010	Coil, 7.5 Turns, 9/64 ID, 20 AWG	3
131-514	Connector, Molex 3 Pin Header	1

200 mW Drive

PART NO.	DESCRIPTION	QUANTITY
240-071	P.C. Board	1
195-003	Hybrid Amplifier, MHW 820 Series	1
161-006	Capacitor, Ceramic Chip, 1000pF	4
160-003	Capacitor, Multilayer 63 V, 0.1uF	3
164-007	Capacitor, Electrolytic 50 V, 2.2 uF	3
157-003	Resistor, Chip 1/8 Watt, 10 Ohms	2
171-010	Coil, 7.5 Turns, 9/64 ID, 20 AWG	3
131-514	Connector, Molex 3 Pin Header	1

NOTE: Refer to Figure 5-1 for location of parts.

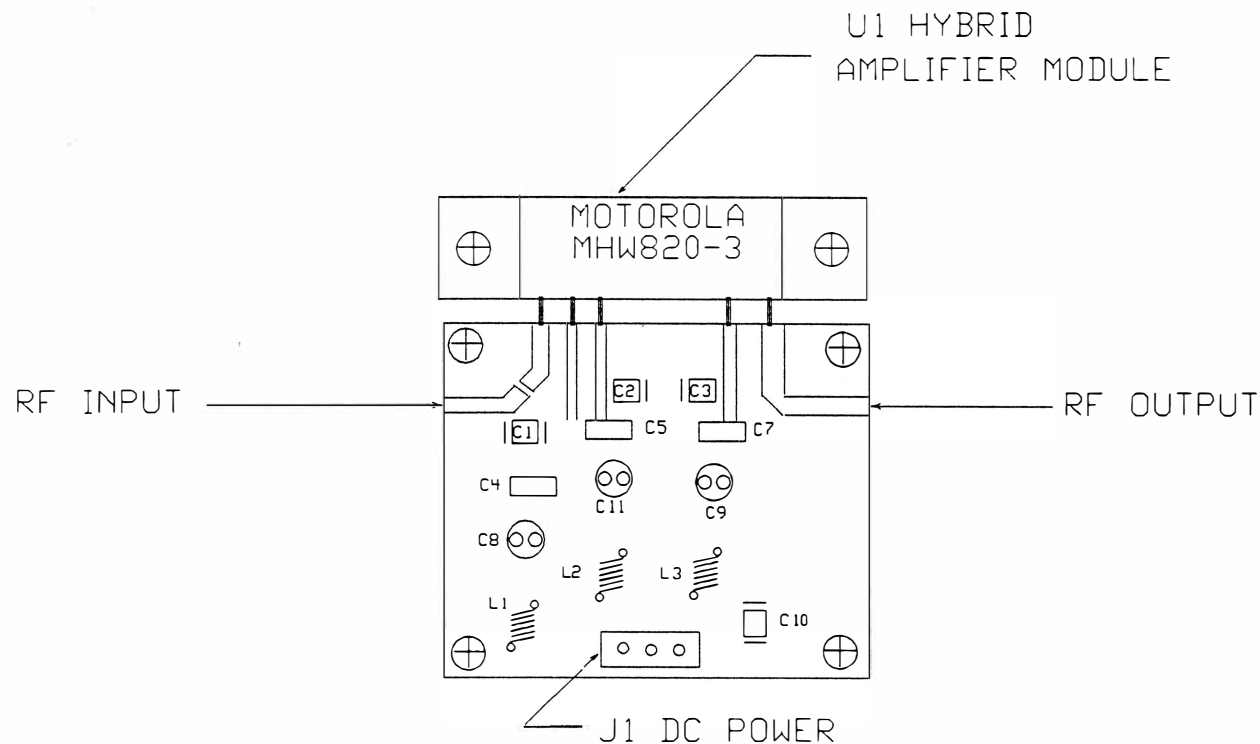


Fig. 5.3-1

PRINTED CIRCUIT BOARD LAYOUT 902-109
 COMPONENT LOCATION AND FOIL PATTERNS
 20 WATT 20 dB GAIN HYBRID POWER AMPLIFIER MODULE
 MODULE ASSEMBLY NO: 540-071

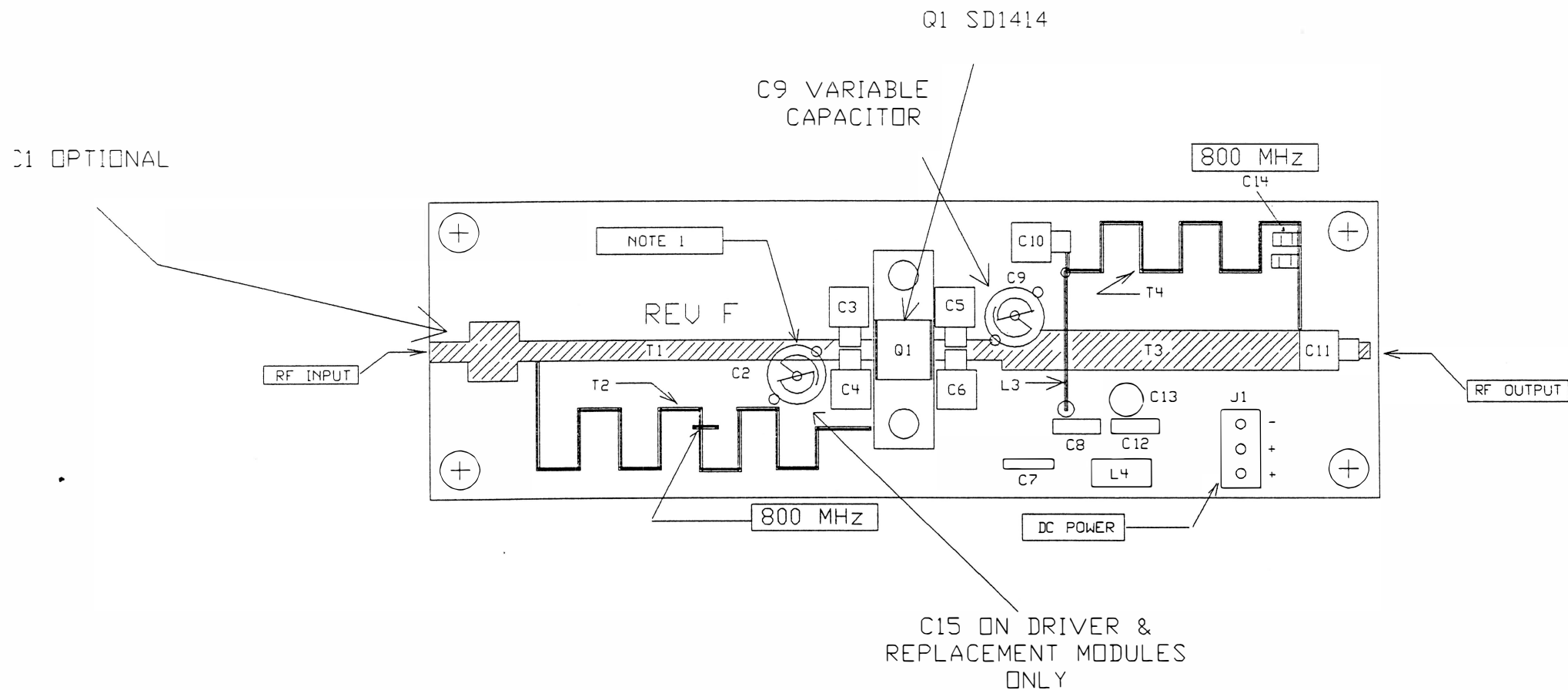
 MILCOM INTERNATIONAL Milcom 10891 CAPITAL AVE GARDEN GROVE, CA 92640		
SCHEMATIC DIAGRAM		
DESCRIPTION 20 W 20 dB GAIN HYBRID POWER AMPLIFIER MODULE		
USED ON		
MODULE ASSEMBLY NO		
CIRCUIT DESCRIPTION NO		
DRAWN BY	LINH LE	DATE 01-11-93
PCB PN	540-071	REV B
TDS 950-133		REV A

BOM 5.3-2

45 Watt, 900 MHz, 14 VDC Common Base Amplifier Part No. 540-061

PART NO.	DESCRIPTION	QUANTITY
162-008	Capacitor, Mini Metal Clad 100pF	1
162-009	Capacitor, Mini Metal Clad 150pF	1
162-003	Capacitor, Mini Metal Clad 10pF	2
162-012	Capacitor, Mini Metal Clad 12pF	2
142-001	Capacitor, Variable, 1.5-5pF	1
160-003	Capacitor, Multilayer CSF, 0.1uF	2
164-007	Capacitor, Electrolytic, 50V, 2.2uF	1
160-001	Capacitor, Ceramic, 500V, .001uF	1
161-005	Capacitor, Porcelain Chip, 56pF	1
161-006	Capacitor, Ceramic Chip, 1000pF	1
171-010	Coil, 20AWG 7.5 Turns 9/64 ID	1
131-514	Connector, Molex 3 Pin SGL Header	1
240-061	PCB, 800MHz,	1
203-002	Transistor, Power SD1414, 12 Volt	1
100-463	Heat Sink, KOL Wings	2

NOTE: Refer to figure 5-3 for location of parts



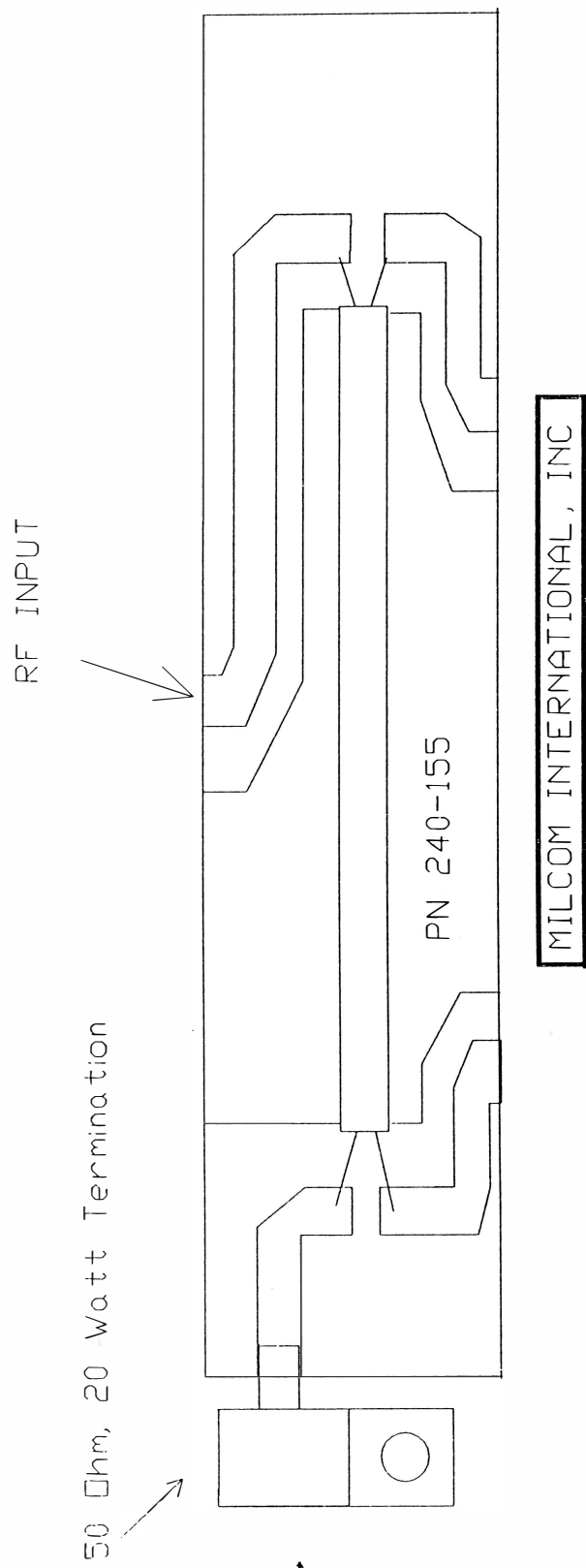
PRINTED CIRCUIT BOARD LAYOUT 902-097
 COMPONENT LOCATIONS AND FOIL PATTERNS
 45 WATT 806-960 MHz POWER AMPLIFIER MODULE
 MODULE ASSEMBLY NO: 540-061 REV. F

BOM 5.3-3

**900 MHz, 2-Way Power Splitter
Part No. 540-155**

PART NO.	DESCRIPTION	QUANTITY
240-155	P.C. Board	1
195-211	Sage, BHCTI 2.0" S-S, Cut 2.5"	1





800/900 MHz 2-Way Splitter
Milcom International, Inc.

Fig. 5.4

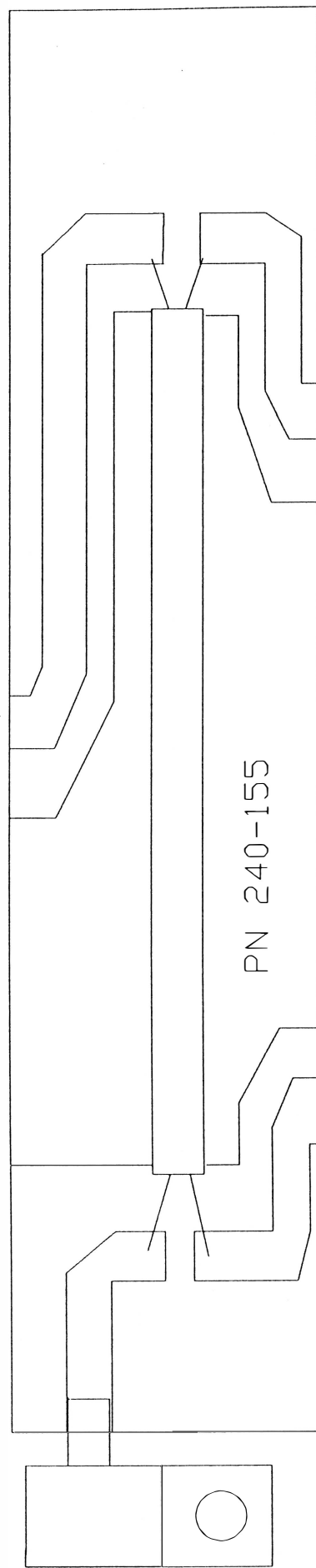
BOM 5.3-4

900 MHz, 2-Way Power Combiner Part No. 240-155

PART NO.	DESCRIPTION	QUANTITY
240-155	P.C. Board	1
195-211	Sage, BHCTI 2.0" S-S, Cut 2.5"	1

RF INPUT

50 Ω m, 20 Watt Termination



MILCOM INTERNATIONAL, INC

900 MHz 2-Way Combiner
Milcom International, Inc.

Fig. 5.5

BOM 5.3-5

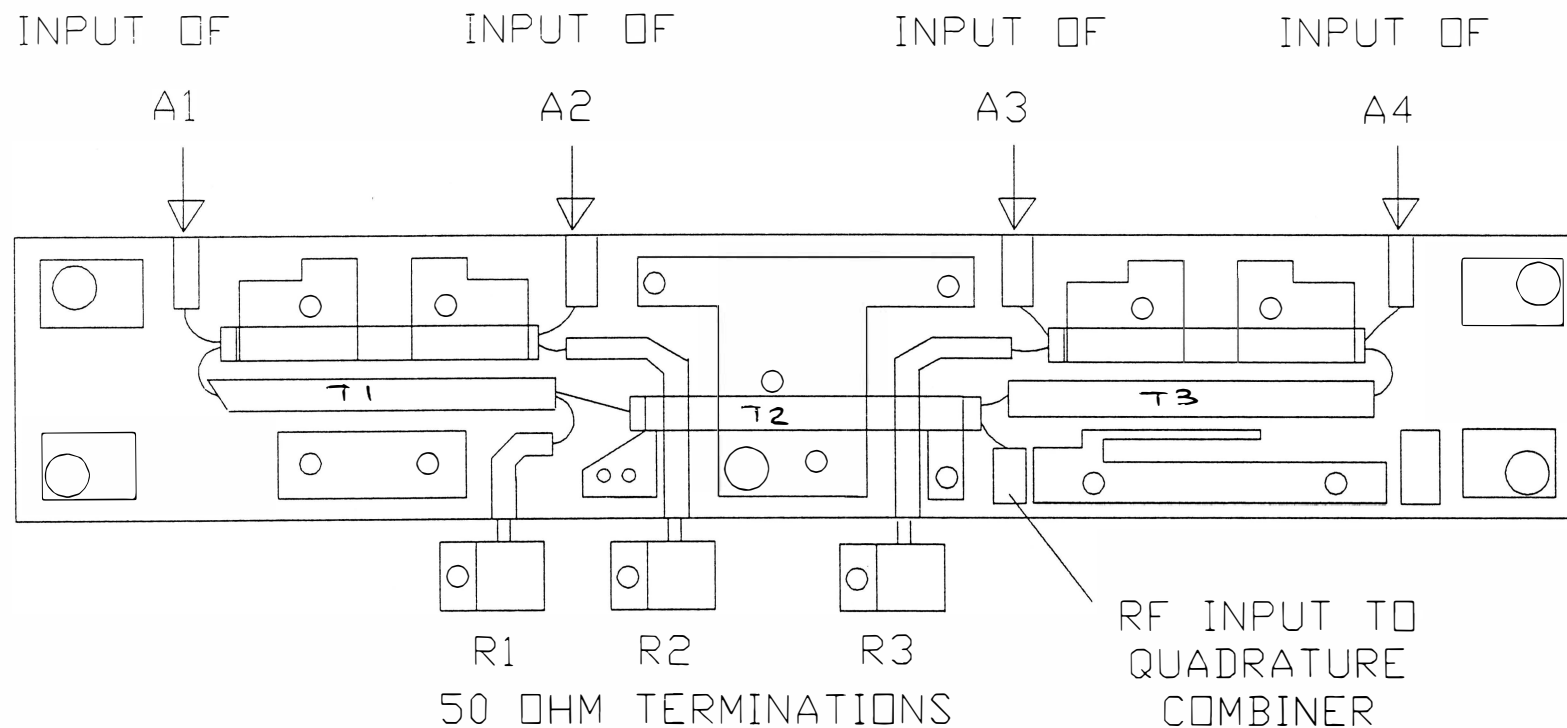
900 MHz, 4 Way Power Splitter Part No. 540-059

PART NO.	DESCRIPTION	QUANTITY
240-059	P.C. Board	1
195-211	Sage, BHCTI 2.0" S-S, Cut 2.5"	3
180-116	Diode, Rec. 08T-MBD701	1
170-008	Ferrite, Ind. 542-FB73-226	1
161-006	Capacitor, Chip Ceramic, 1000pF	1
160-004	Capacitor, Multilayer CSF	1

NOTE: Refer to Figure for location of parts.



MILCOM PART NO. 240-095 REV. F
4 WAY 800/900 MHZ QUAD SPLITTER



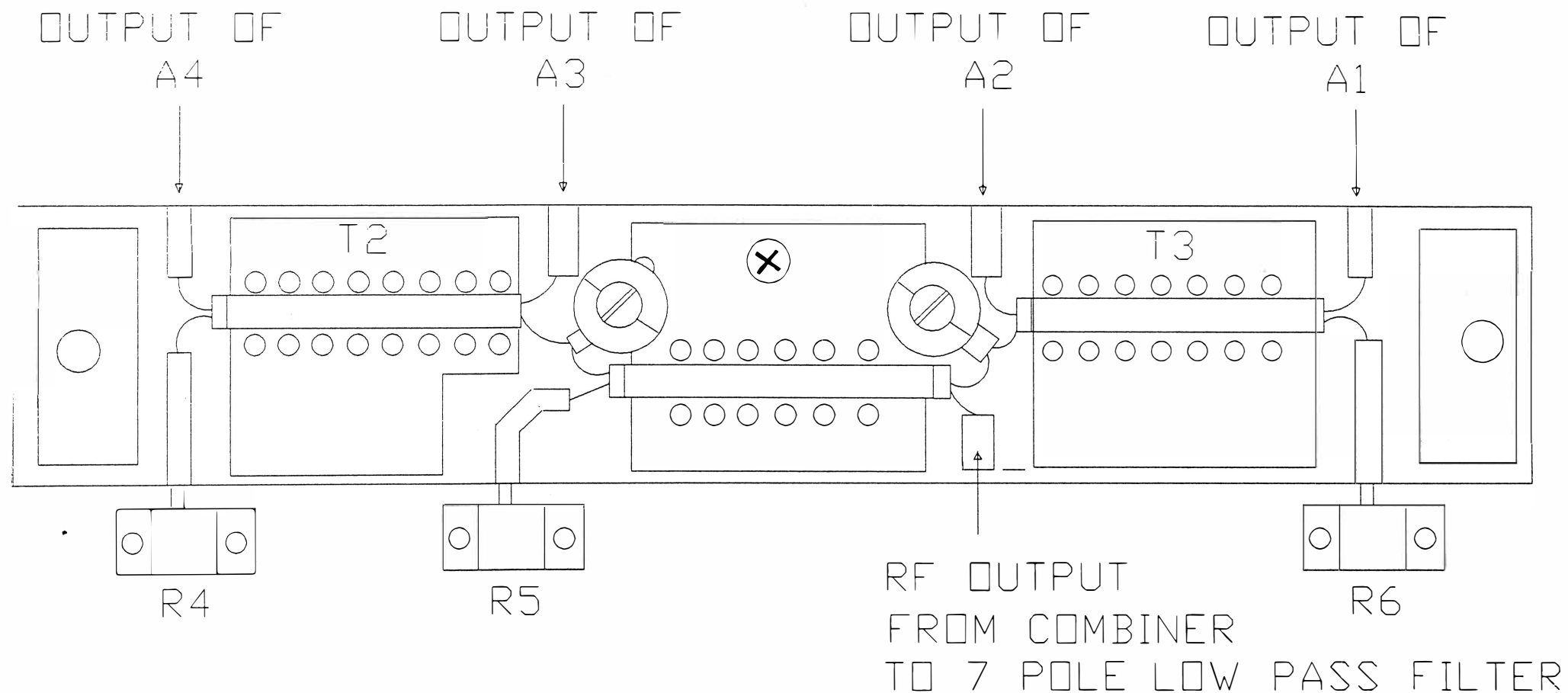
PRINTED CIRCUIT BOARD LAYOUT 902-090
COMPONENT LOCATIONS AND FOIL TRACE PATTERNS
4 WAY QUADRATURE POWER SPLITTER 806-940 MHz
MODULE ASSEMBLY NO.: 540-059

BOM 5.3-6

900 MHz, 4 Way Power Combiner Part No. 540-087C

PART NO.	DESCRIPTION	QUANTITY
240-087C	P.C. Board	1
195-212	Sage, BJCTI 2.0" S-S, Cut 2.5"	3
142-001	Capacitor, Variable 1.5 to 5 pF	2

NOTE: Refer to Figure for location of parts.



COMPONENT LOCATIONS AND FOIL PATTERNS
 4 WAY QUADRATURE COMBINER 806-940 MHz
 MODULE ASSEMBLY NO: 540-087C

Fig. 5.5

BOM 5.3-7

7 Pole Low Pass Filter, 960 MHz Cut Off Part No. 540-066

PART NO.	DESCRIPTION	QUANTITY
240-066	P.C. Board	1
100-146	"U" Shaped Coil	3

NOTE: Refer to Figure for location of parts

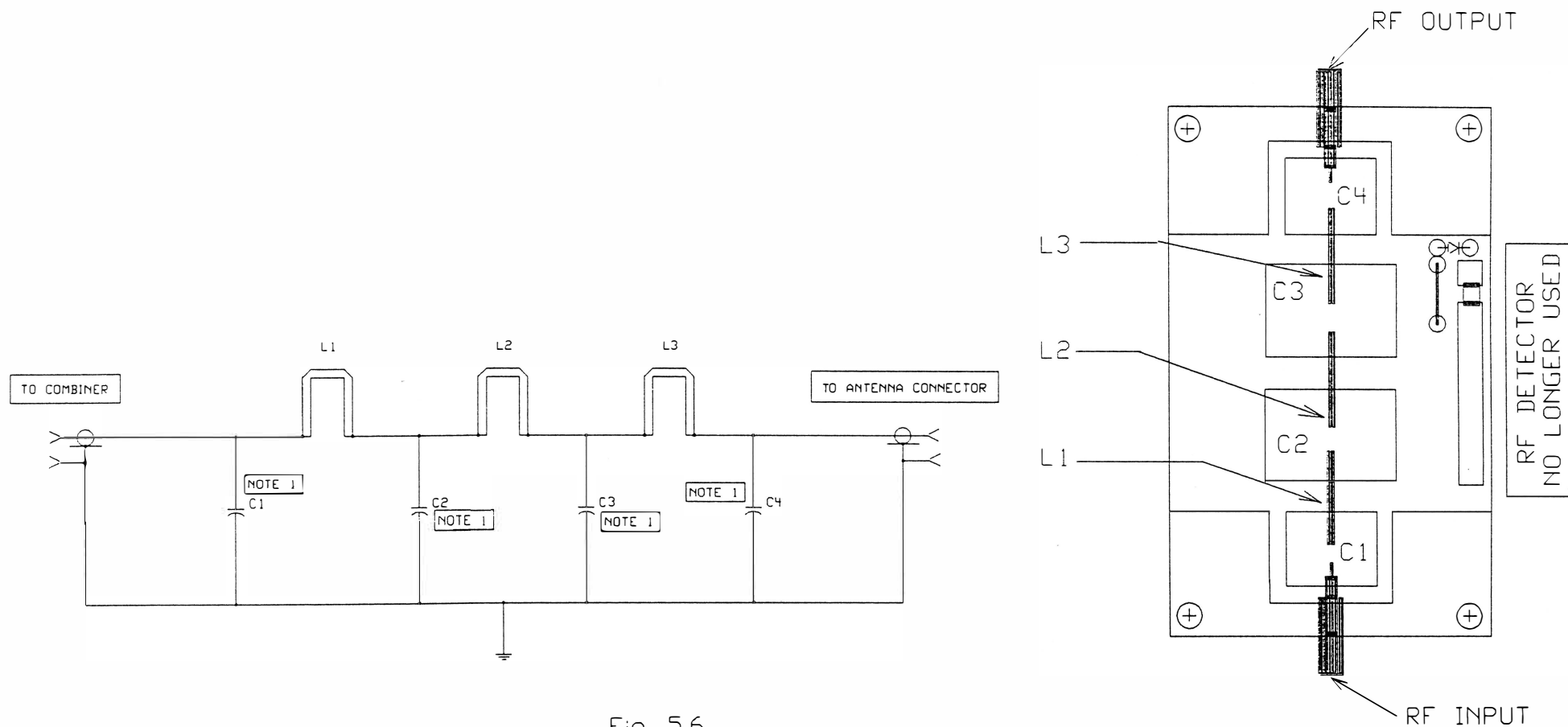


Fig. 5.6

NOTES

1 C1,C2,C3,C4 ARE PRINTED CIRCUIT BOARD CAPACITORS

PRODUCT	ASSEMBLY REFERENCE NO	MILCOM INTERNATIONAL	
		SCHEMATIC DIAGRAM 902-103	
P15-05L1	A12	DESCRIPTION	7 POLE LOW PASS FILTER 890 MHZ C/O
P25-05L1	A12	USED ON	ALL 806 TO 960 MHZ RF AMPLIFIERS
P25-2L1	A12	MODULE ASSEMBLY NO	540-066A
		PRINTED CIRCUIT BOARD LAYOUT NO	902-104
		BILL OF MATERIALS DWG NO	902-105
		CIRCUIT DESCRIPTION NO	TD 114
			960LPFSC

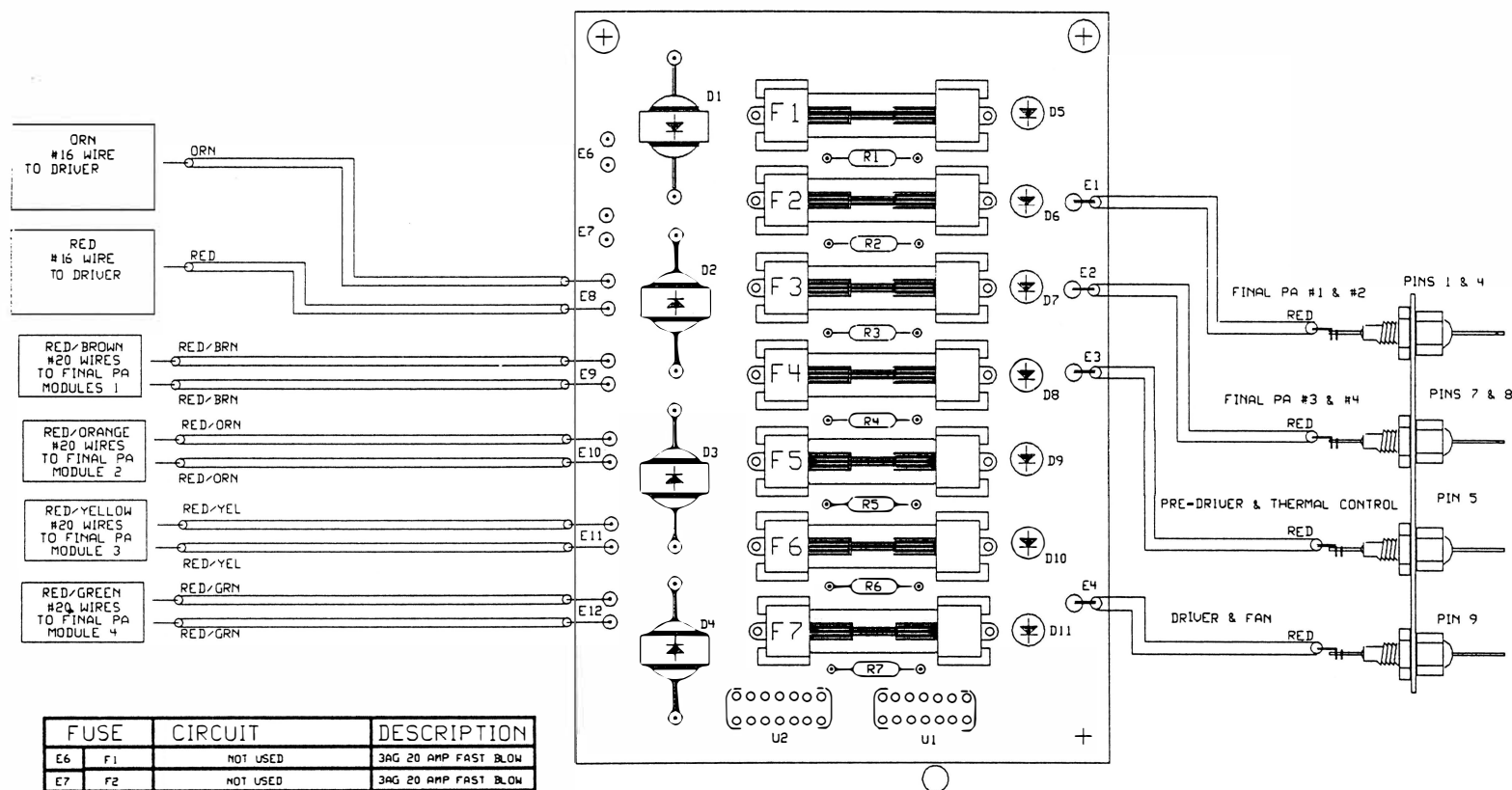
BOM 5.3-8

DC DISTRIBUTION BOARD PART NO. 540-083A

PART NO.	DESCRIPTION	QUANTITY
240-083	P.C. Board	1
151-122	Resistor, 1/4 Watt 1.2 Ohm	7
139-106	LED, and 123G Mini	7
180-002	Diode, Rec. MR751 P600A	4
136-107	Fuses, 20 Ampere	7
136-103	Fuses, Fuse Clip	14
115-015	Wire, #18 AWG (Red) Qty. Feet	1

NOTE: Refer to figure for location of parts





DC POWER DISTRIBUTION AND FUSE BOARD
PICTORIAL & CONNECTIONS

MILCOM INTERNATIONAL	
MILCOM 10891 CAPITAL AVE GARDEN GROVE, CA 92640	
SCHEMATIC DIAGRAM	
DESCRIPTION	OUTLINE DRAWING - DC DISTRIBUTION BOARD
USED ON	150 WATT, 900 MHz AMPLIFIER
CIRCUIT DESCRIPTION NO	N/A
DRAWN BY	L. LE. DATE 01-13-93
PCB PN	240-083 REV E
TDS 950-129	REV: A

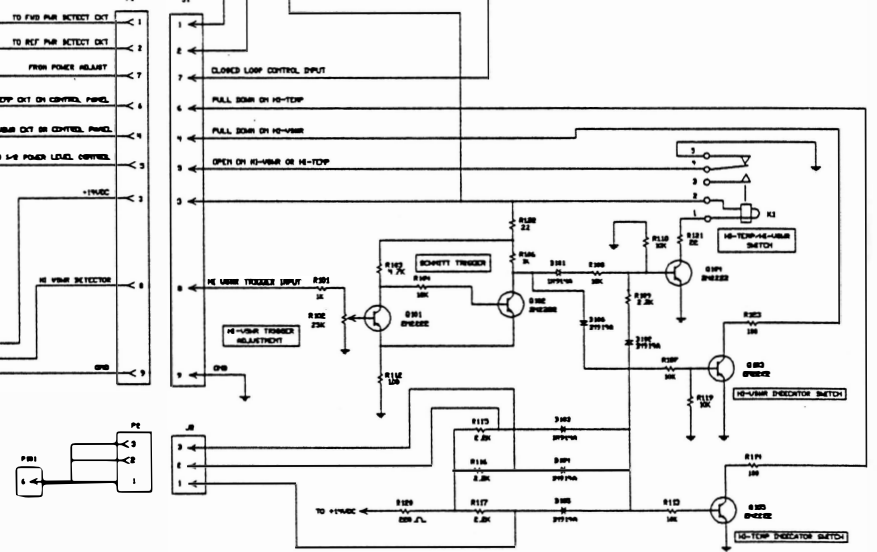
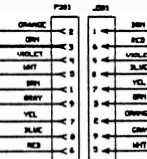
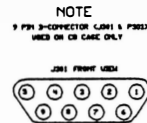
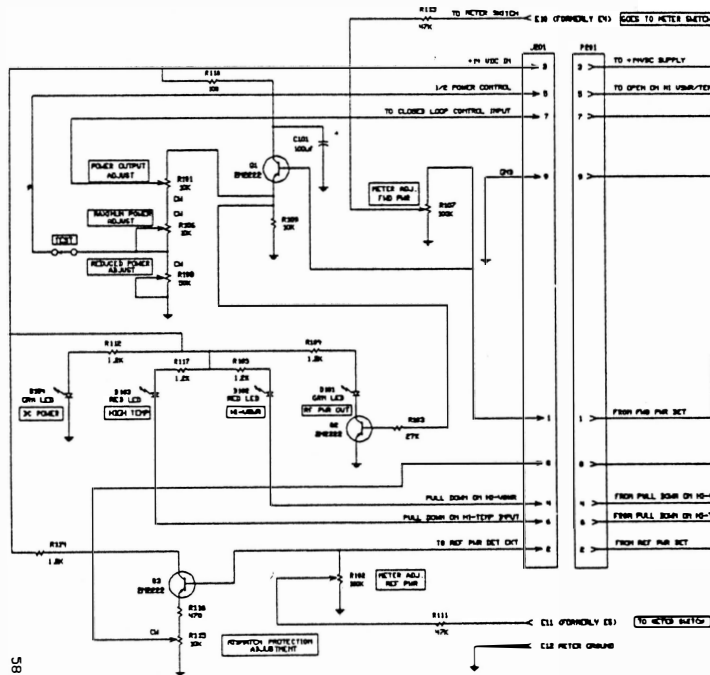
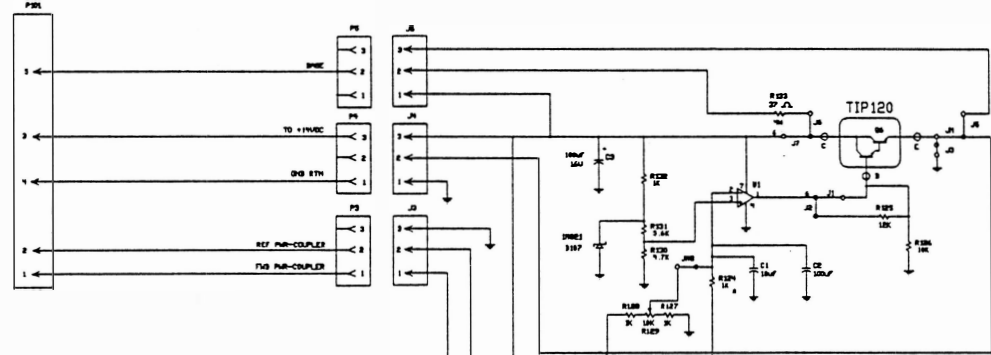
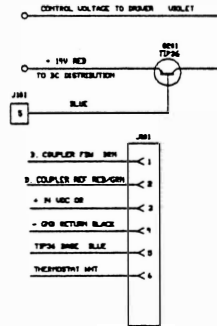
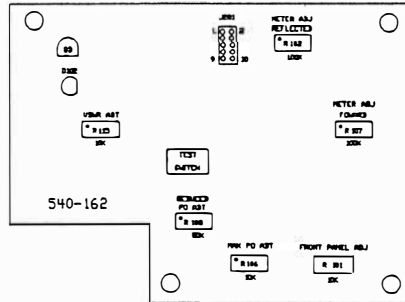
BOM 5.3-9

**Power Meter Control Board
Part No. 540-162**

Part No.	Description	Quantity
-----------------	--------------------	-----------------

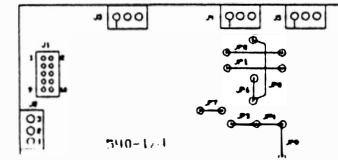
NOTE: Refer to Figure for location of parts.

CONTROL PANEL SIMPLIFIED LAYOUT



MILCOM INTERNATIONAL	
10891 CAPITAL AVE. GARDEN GROVE, CA 92640	
CONTROL MODULE/CONTROL PANEL	
DESCRIPTION POWER/USWR/HI-TEMP CONTROL SCHEMATIC/DC INTERCONN & SIMPLIFIED LAYOUT	
USED ON ALL KW SERIES AMPS WHICH HAVE PWR TEMP-USWR CONTROL AND OR PWR MONITOR	
PCB PN	240-162 REV C AND 240-174 REV B
DRAWN BY	MAXWELL
DATE	6-14-91
TDC 950-077 RFU A	

CONTROL BOARD SIMPLIFIED LAYOUT



BOM 5.3-10

**Power Output Control Board
Part No. 540-174**

ZZ-01226-02-ZA

(12.800 KHz)

D-Box

PN-240-061 - Rev F.
800MHz, 45W - Power Amp. 12VDC.

Assy 540-380 Rev.
4way 800MHz Quad Combiner

Long. ϕ = 46.5 cm

PA - 28 cm

PDIT - 14 cm

66 -